

# REF50xx

## Low-Noise, Very Low Drift, Precision Voltage Reference

### 1 Features

- Low temperature drift:
  - High-grade: 3 ppm/°C (Max)
  - Standard-grade: 8 ppm/°C (Max)
- High Accuracy:
  - High-grade: 0.05% (Max)
  - Standard-grade: 0.1% (Max)
- Low noise: 3  $\mu\text{V}_{\text{PP}}/\text{V}$
- Excellent long-term stability:
  - 50 ppm/1000 hr (Typ) First 1000 hours (VSSOP)
  - 25 ppm/1000 hr (Typ) Second 2000 hours (VSSOP)
- High-Output Current:  $\pm 10\text{ mA}$
- Temperature range:  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$

### 2 Applications

- [Precision data acquisition systems](#)
- [Semiconductor test equipment](#)
- [Industrial process controls](#)
- [Medical instrumentation](#)
- [Pressure and temperature transmitters](#)
- [Lab and field instrumentation](#)

### 3 Description

The REF50xx is a family of low-noise, low-drift, very high precision voltage references. These references are capable of both sinking and sourcing current, and have excellent line and load regulation.

Excellent temperature drift (3 ppm/°C) and high accuracy (0.05%) are achieved using proprietary design techniques. These features, combined with very low noise, make the REF50xx family ideal for use in high-precision data acquisition systems.

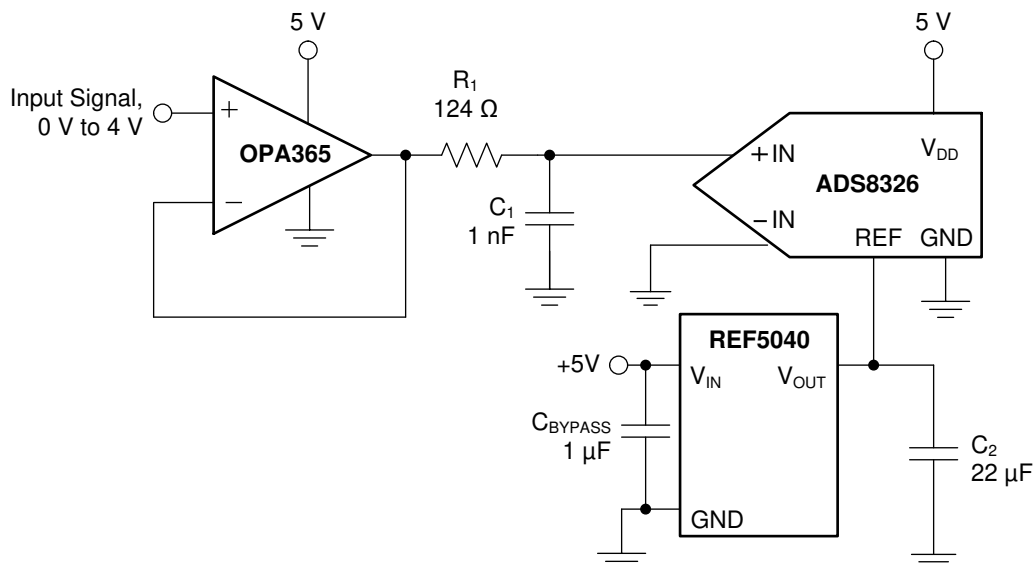
Each reference voltage is available in both high grade (REF50xxIDGK and REF50xxID) and standard grade (REF50xxAIDGK and REF50xxAID). The reference voltages are offered in 8-pin VSSOP and SOIC packages, and are specified from  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ .

#### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE   | BODY SIZE (NOM)   |
|-------------|-----------|-------------------|
| REF50xx     | SOIC (8)  | 4.90 mm × 3.91 mm |
|             | VSSOP (8) | 3.00 mm × 3.00 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

#### Simplified Schematic



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## Table of Contents

|                                                  |           |                                                                  |           |
|--------------------------------------------------|-----------|------------------------------------------------------------------|-----------|
| <b>1 Features</b> .....                          | <b>1</b>  | 9.4 Device Functional Modes.....                                 | <b>19</b> |
| <b>2 Applications</b> .....                      | <b>1</b>  | <b>10 Applications and Implementation</b> .....                  | <b>20</b> |
| <b>3 Description</b> .....                       | <b>1</b>  | 10.1 Application Information.....                                | <b>20</b> |
| <b>4 Revision History</b> .....                  | <b>2</b>  | 10.2 Typical Applications .....                                  | <b>20</b> |
| <b>5 Device Comparison Table</b> .....           | <b>4</b>  | <b>11 Power Supply Recommendations</b> .....                     | <b>22</b> |
| <b>6 Pin Configuration and Functions</b> .....   | <b>4</b>  | <b>12 Layout</b> .....                                           | <b>22</b> |
| <b>7 Specifications</b> .....                    | <b>5</b>  | 12.1 Layout Guidelines .....                                     | <b>22</b> |
| 7.1 Absolute Maximum Ratings .....               | <b>5</b>  | 12.2 Layout Example .....                                        | <b>22</b> |
| 7.2 ESD Ratings.....                             | <b>5</b>  | 12.3 Power Dissipation .....                                     | <b>22</b> |
| 7.3 Recommended Operating Conditions.....        | <b>5</b>  | <b>13 Device and Documentation Support</b> .....                 | <b>23</b> |
| 7.4 Thermal Information .....                    | <b>5</b>  | 13.1 Documentation Support .....                                 | <b>23</b> |
| 7.5 Electrical Characteristics.....              | <b>6</b>  | 13.2 Related Links .....                                         | <b>23</b> |
| 7.6 Typical Characteristics.....                 | <b>8</b>  | 13.3 Receiving Notification of Documentation Updates             | <b>23</b> |
| <b>8 Parameter Measurement Information</b> ..... | <b>13</b> | 13.4 Support Resources .....                                     | <b>23</b> |
| <b>9 Detailed Description</b> .....              | <b>15</b> | 13.5 Trademarks .....                                            | <b>23</b> |
| 9.1 Overview .....                               | <b>15</b> | 13.6 Electrostatic Discharge Caution.....                        | <b>23</b> |
| 9.2 Functional Block Diagram .....               | <b>15</b> | 13.7 Glossary .....                                              | <b>23</b> |
| 9.3 Feature Description.....                     | <b>16</b> | <b>14 Mechanical, Packaging, and Orderable Information</b> ..... | <b>24</b> |

## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision H (June 2016) to Revision I           | Page      |
|-------------------------------------------------------------|-----------|
| • Added <i>REF5045</i> to table .....                       | <b>6</b>  |
| • Changed <i>Long-Term Stability</i> parameters.....        | <b>6</b>  |
| • Changed <i>Long-Term Stability</i> Graphs for VSSOP ..... | <b>11</b> |
| • Added section on <i>Long-Term Stability</i> .....         | <b>17</b> |

| Changes from Revision G (November 2015) to Revision H                                                    | Page      |
|----------------------------------------------------------------------------------------------------------|-----------|
| • Changed all ( <i>Maximum</i> ) to ( <i>Max</i> ) in <i>Features</i> section .....                      | <b>1</b>  |
| • Changed <i>MSOP</i> to <i>VSSOP</i> and <i>SO</i> to <i>SOIC</i> throughout document .....             | <b>1</b>  |
| • Added TI Design .....                                                                                  | <b>1</b>  |
| • Changed first <i>Applications</i> bullet .....                                                         | <b>1</b>  |
| • Changed last paragraph of <i>Description</i> section .....                                             | <b>1</b>  |
| • Changed <i>Simplified Schematic</i> .....                                                              | <b>1</b>  |
| • Changed device name in <i>Recommended Operating Conditions</i> table footnote .....                    | <b>5</b>  |
| • Added <i>Output Voltage</i> and <i>Noise</i> sections to <i>Electrical Characteristics</i> table ..... | <b>6</b>  |
| • Changed third bullet in <i>Layout Guidelines</i> section .....                                         | <b>22</b> |

| Changes from Revision F (December 2013) to Revision G                                                                                                                                                                                                                                                                                                | Page     |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|
| • Added <i>ESD Ratings</i> table, <i>Feature Description</i> section, <i>Device Functional Modes</i> , <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section ..... | <b>1</b> |

**Changes from Revision E (June 2010) to Revision F**
**Page**

|                                                                     |           |
|---------------------------------------------------------------------|-----------|
| • Changed <i>Excellent Long-Term Stability</i> feature bullet ..... | <b>1</b>  |
| • Changed <i>Thermal Hysteresis</i> typical values .....            | <b>6</b>  |
| • Changed <i>Long-Term Stability</i> typical values .....           | <b>6</b>  |
| • Added note 3 to <i>Electrical Characteristics</i> .....           | <b>6</b>  |
| • Changed <a href="#">Figure 22</a> .....                           | <b>10</b> |
| • Changed <a href="#">Figure 23</a> .....                           | <b>10</b> |
| • Changed <a href="#">Figure 24</a> .....                           | <b>10</b> |
| • Changed <a href="#">Figure 27</a> .....                           | <b>11</b> |
| • Changed <a href="#">Figure 28</a> .....                           | <b>11</b> |
| • Changed <a href="#">Figure 29</a> .....                           | <b>11</b> |

**Changes from Revision D (April 2009) to Revision E**
**Page**

|                                                                                                       |           |
|-------------------------------------------------------------------------------------------------------|-----------|
| • Updated <i>Features</i> list; added <i>Excellent Long-Term Stability</i> bullet .....               | <b>1</b>  |
| • Added <i>Thermal Hysteresis</i> parameters and specifications .....                                 | <b>6</b>  |
| • Added <i>Long-Term Stability</i> parameters and specifications .....                                | <b>6</b>  |
| • Added <a href="#">Figure 22</a> through <a href="#">Figure 24</a> .....                             | <b>10</b> |
| • Added <a href="#">Figure 27</a> through <a href="#">Figure 29</a> .....                             | <b>11</b> |
| • Added <i>Thermal Hysteresis</i> section .....                                                       | <b>16</b> |
| • Revised <i>Noise Performance</i> section; added paragraph with links to applications articles ..... | <b>17</b> |

**Changes from Revision C (December 2008) to Revision D**
**Page**

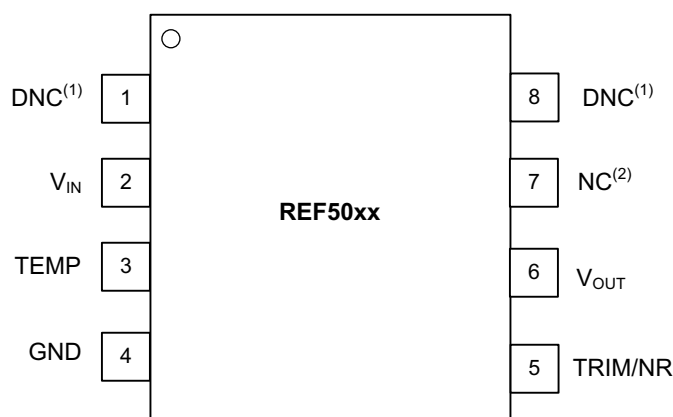
|                                                                                                                     |          |
|---------------------------------------------------------------------------------------------------------------------|----------|
| • Removed all notes regarding MSOP-8 package status. MSOP-8 package released at time of document revision .....     | <b>1</b> |
| • Changed <i>Storage Temperature Range</i> absolute minimum value from –55°C to –65°C .....                         | <b>5</b> |
| • Added <i>Load Regulation</i> test condition and <i>Over Temperature</i> specifications .....                      | <b>6</b> |
| • Added typical characteristic graph, <i>Quiescent Current vs Input Voltage</i> ( <a href="#">Figure 10</a> ) ..... | <b>8</b> |

## 5 Device Comparison Table

| MODEL   | OUTPUT VOLTAGE |
|---------|----------------|
| REF5020 | 2.048 V        |
| REF5025 | 2.5 V          |
| REF5030 | 3 V            |
| REF5040 | 4.096 V        |
| REF5045 | 4.5 V          |
| REF5050 | 5 V            |
| REF5010 | 10 V           |

## 6 Pin Configuration and Functions

D, DGK Packages  
8-Pin SOIC, VSSOP  
Top View



NOTES: (1) DNC = Do not connect.  
(2) NC = No internal connection.

### Pin Functions

| PIN     |     | DESCRIPTION                                                                 |
|---------|-----|-----------------------------------------------------------------------------|
| NAME    | NO. |                                                                             |
| DNC     | 1   | Do not connect                                                              |
| VIN     | 2   | Input supply voltage                                                        |
| TEMP    | 3   | Temperature monitoring pin. Provides a temperature-dependent output voltage |
| GND     | 4   | Ground                                                                      |
| TRIM/NR | 5   | Output adjustment and noise reduction pin                                   |
| VOUT    | 6   | Reference voltage output                                                    |
| NC      | 7   | No internal connection                                                      |
| DNC     | 8   | Do not connect                                                              |

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                                           | MIN  | MAX | UNIT |
|-------------------------------------------|------|-----|------|
| Input voltage                             | –0.2 | 18  | V    |
| Output short circuit                      | –30  | 30  | mA   |
| Operating temperature                     | –55  | 125 | °C   |
| Junction temperature (T <sub>J</sub> max) |      | 150 | °C   |
| Storage temperature, T <sub>stg</sub>     | –65  | 150 | °C   |

- (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

### 7.2 ESD Ratings

|                                            |                                                                                | VALUE | UNIT |
|--------------------------------------------|--------------------------------------------------------------------------------|-------|------|
| V <sub>(ESD)</sub> Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±3000 | V    |
|                                            | Charged device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±1000 |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                  | MIN                                     | NOM | MAX | UNIT |
|------------------|-----------------------------------------|-----|-----|------|
| V <sub>IN</sub>  | V <sub>OUT</sub> + 0.2 V <sup>(1)</sup> |     | 18  | V    |
| I <sub>OUT</sub> | –10                                     |     | 10  | mA   |

- (1) Except for the REF5020, where V<sub>IN</sub> (min) = 2.7 V.

### 7.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | REF50xx  |             | UNIT |
|-------------------------------|----------------------------------------------|----------|-------------|------|
|                               |                                              | D (SOIC) | DGK (VSSOP) |      |
|                               |                                              | 8 PINS   | 8 PINS      |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 115      | 160.9       | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 63.4     | 53.9        | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 57.1     | 82.3        | °C/W |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 15.4     | 5.1         | °C/W |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 56.2     | 80.7        | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | N/A      | N/A         | °C/W |

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

## 7.5 Electrical Characteristics

At  $T_A = 25^\circ\text{C}$ ,  $I_{\text{LOAD}} = 0$ ,  $C_L = 1\ \mu\text{F}$ , and  $V_{\text{IN}} = (V_{\text{OUT}} + 0.2\ \text{V})$  to 18 V, unless otherwise noted.

| PARAMETER                             |                                  | TEST CONDITIONS                                                                                                                      |         | MIN    | TYP | MAX                 | UNIT   |
|---------------------------------------|----------------------------------|--------------------------------------------------------------------------------------------------------------------------------------|---------|--------|-----|---------------------|--------|
| OUTPUT VOLTAGE                        |                                  |                                                                                                                                      |         |        |     |                     |        |
| V <sub>OUT</sub>                      | Output Voltage                   | REF5020 (V <sub>OUT</sub> = 2.048 V) <sup>(1)</sup> ,<br>2.7 V < V <sub>IN</sub> < 18 V                                              |         | 2.048  |     | V                   |        |
|                                       |                                  | REF5025                                                                                                                              |         | 2.5    |     |                     |        |
|                                       |                                  | REF5030                                                                                                                              |         | 3.0    |     |                     |        |
|                                       |                                  | REF5040                                                                                                                              |         | 4.096  |     |                     |        |
|                                       |                                  | REF5045                                                                                                                              |         | 4.5    |     |                     |        |
|                                       |                                  | REF5050                                                                                                                              |         | 5.0    |     |                     |        |
|                                       |                                  | REF5010                                                                                                                              |         | 10.0   |     |                     |        |
| Initial Accuracy: High Grade          |                                  | All voltage options <sup>(1)</sup>                                                                                                   |         | −0.05% |     | 0.05%               |        |
| Initial Accuracy: Standard Grade      |                                  | All voltage options <sup>(1)</sup>                                                                                                   |         | −0.1%  |     | 0.1%                |        |
| NOISE                                 |                                  |                                                                                                                                      |         |        |     |                     |        |
| Output Voltage Noise                  |                                  | f = 0.1 Hz to 10 Hz                                                                                                                  |         | 3      |     | μV <sub>PP</sub> /V |        |
| OUTPUT VOLTAGE TEMPERATURE DRIFT      |                                  |                                                                                                                                      |         |        |     |                     |        |
| dV <sub>OUT</sub> /dT                 | Output Voltage Temperature Drift |                                                                                                                                      |         |        |     |                     |        |
|                                       | High-Grade                       |                                                                                                                                      |         | 2.5    |     | 3                   | ppm/°C |
|                                       | Standard-Grade                   |                                                                                                                                      |         | 3      |     | 8                   | ppm/°C |
| LINE REGULATION                       |                                  |                                                                                                                                      |         |        |     |                     |        |
| ΔV <sub>O(ΔV)</sub>                   | Line Regulation                  | V <sub>IN</sub> = (V <sub>OUT</sub> + 0.2) to 18 V <sup>(2)</sup>                                                                    |         | 0.1    |     | 1                   | ppm/V  |
|                                       |                                  | V <sub>IN</sub> = V <sub>OUT</sub> + 0.2 V,<br>T <sub>A</sub> = −40°C to 125°C <sup>(2)</sup>                                        |         | 0.2    |     | 1                   | ppm/V  |
| LOAD REGULATION                       |                                  |                                                                                                                                      |         |        |     |                     |        |
| ΔV <sub>O(ΔI)</sub>                   | Load Regulation                  | −10 mA < I <sub>LOAD</sub> < 10 mA,<br>V <sub>IN</sub> = V <sub>OUT</sub> + 0.75 V <sup>(3)</sup>                                    |         | 20     |     | 30                  | ppm/mA |
|                                       |                                  | −10 mA < I <sub>LOAD</sub> < 10 mA,<br>V <sub>IN</sub> = V <sub>OUT</sub> + 0.75 V<br>T <sub>A</sub> = −40°C to 125°C <sup>(3)</sup> |         |        |     | 50                  | ppm/mA |
| SHORT-CIRCUIT CURRENT                 |                                  |                                                                                                                                      |         |        |     |                     |        |
| I <sub>SC</sub>                       | Short circuit current            | V <sub>OUT</sub> = 0                                                                                                                 |         | 25     |     | mA                  |        |
| THERMAL HYSTERESIS <sup>(4) (5)</sup> |                                  |                                                                                                                                      |         |        |     |                     |        |
|                                       | High-Grade                       | VSSOP-8                                                                                                                              | Cycle 1 | 50     |     | ppm                 |        |
|                                       | Standard-Grade                   | VSSOP-8                                                                                                                              | Cycle 1 | 70     |     | ppm                 |        |
|                                       | High-Grade                       | SOIC-8                                                                                                                               | Cycle 1 | 70     |     | ppm                 |        |
|                                       | Standard-Grade                   | SOIC-8                                                                                                                               | Cycle 1 | 90     |     | ppm                 |        |
|                                       | High-Grade                       | VSSOP-8                                                                                                                              | Cycle 2 | 40     |     | ppm                 |        |
|                                       | Standard-Grade                   | VSSOP-8                                                                                                                              | Cycle 2 | 40     |     | ppm                 |        |
|                                       | High-Grade                       | SOIC-8                                                                                                                               | Cycle 2 | 50     |     | ppm                 |        |
|                                       | Standard-Grade                   | SOIC-8                                                                                                                               | Cycle 2 | 50     |     | ppm                 |        |
| LONG-TERM STABILITY <sup>(5)</sup>    |                                  |                                                                                                                                      |         |        |     |                     |        |
|                                       | VSSOP-8                          | 0 to 1000 hours                                                                                                                      |         | 50     |     | ppm/1000 hr         |        |
|                                       | VSSOP-8                          | 1000 to 2000 hours                                                                                                                   |         | 25     |     | ppm/1000 hr         |        |
|                                       | SOIC-8                           | 0 to 1000 hours                                                                                                                      |         | 100    |     | ppm/1000 hr         |        |
|                                       | SOIC-8                           | 1000 to 2000 hours                                                                                                                   |         | 50     |     | ppm/1000 hr         |        |
| TEMP PIN                              |                                  |                                                                                                                                      |         |        |     |                     |        |
| Voltage Output                        |                                  | At T <sub>A</sub> = 25°C                                                                                                             |         | 575    |     | mV                  |        |
| Temperature Sensitivity               |                                  | T <sub>A</sub> = -40°C to 125°C                                                                                                      |         | 2.64   |     | mV/°C               |        |
| TURNON SETTLING TIME                  |                                  |                                                                                                                                      |         |        |     |                     |        |
| Turnon Settling Time                  |                                  | To 0.1% with C <sub>L</sub> = 1 μF                                                                                                   |         | 200    |     | μs                  |        |

(1) For  $V_{\text{OUT}} \leq 2.5\ \text{V}$ , the minimum supply voltage is 2.7 V.

(2) Except for REF5020, where  $V_{\text{IN}} = 2.7\ \text{V}$  to 18 V.

(3) Except for REF5020, where  $V_{\text{IN}} = 3\ \text{V}$ .

(4) The thermal hysteresis procedure is explained in more detail in the [Thermal Hysteresis](#) section.

(5) Data collected using devices soldered onto the test board.

## Electrical Characteristics (continued)

At  $T_A = 25^\circ\text{C}$ ,  $I_{\text{LOAD}} = 0$ ,  $C_L = 1\ \mu\text{F}$ , and  $V_{\text{IN}} = (V_{\text{OUT}} + 0.2\ \text{V})$  to 18 V, unless otherwise noted.

| PARAMETER         |                   | TEST CONDITIONS                 | MIN                                   | TYP | MAX | UNIT |
|-------------------|-------------------|---------------------------------|---------------------------------------|-----|-----|------|
| POWER SUPPLY      |                   |                                 |                                       |     |     |      |
| V <sub>S</sub>    | Supply Voltage    | See Note <sup>(1)</sup>         | V <sub>OUT</sub> + 0.2 <sup>(1)</sup> |     | 18  | V    |
|                   | Quiescent Current |                                 | 0.8                                   |     | 1   | mA   |
|                   |                   | T <sub>A</sub> = -40°C to 125°C |                                       |     | 1.2 | mA   |
| TEMPERATURE RANGE |                   |                                 |                                       |     |     |      |
|                   | Specified Range   |                                 | –40                                   |     | 125 | °C   |
|                   | Operating Range   |                                 | –55                                   |     | 125 | °C   |

## 7.6 Typical Characteristics

At  $T_A = 25^\circ\text{C}$ ,  $I_{\text{LOAD}} = 0$ , and  $V_S = V_{\text{OUT}} + 0.2\text{ V}$ , unless otherwise noted. For  $V_{\text{OUT}} \leq 2.5\text{ V}$ , the minimum supply voltage is 2.7 V.

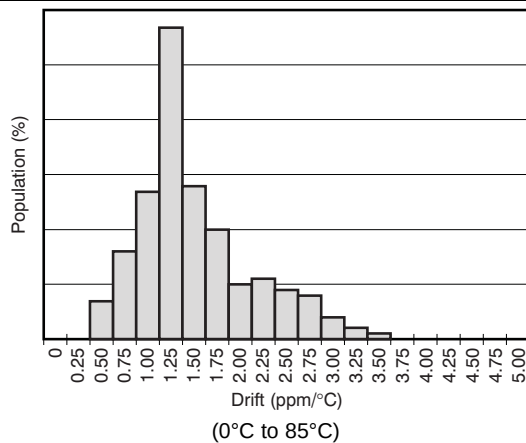


Figure 1. Temperature Drift

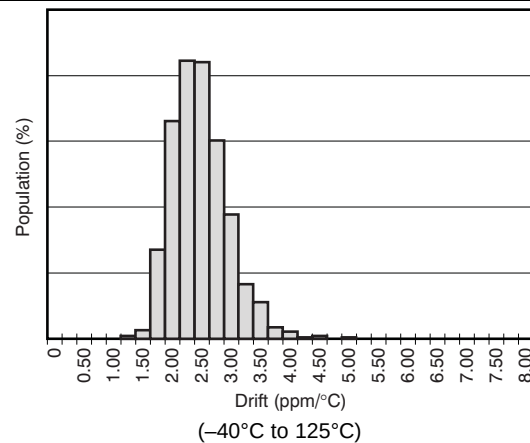


Figure 2. Temperature Drift

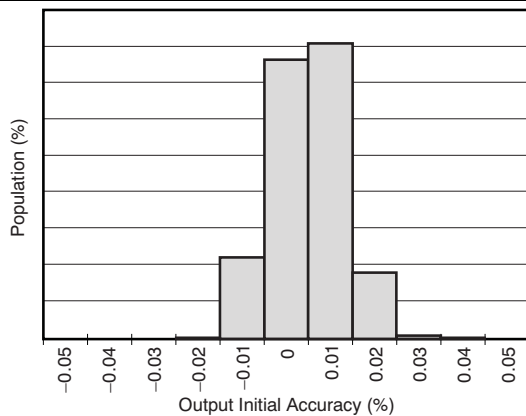


Figure 3. Output Voltage Initial Accuracy

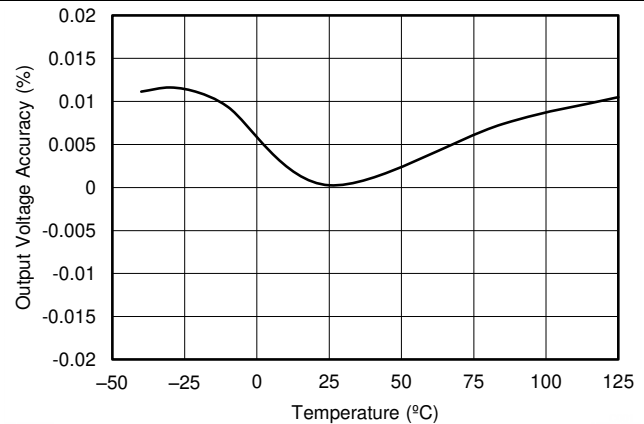


Figure 4. Output Voltage Accuracy vs Temperature

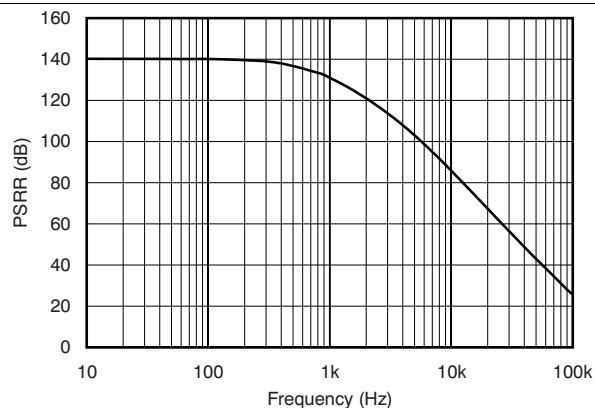


Figure 5. Power-Supply Rejection Ratio vs Frequency

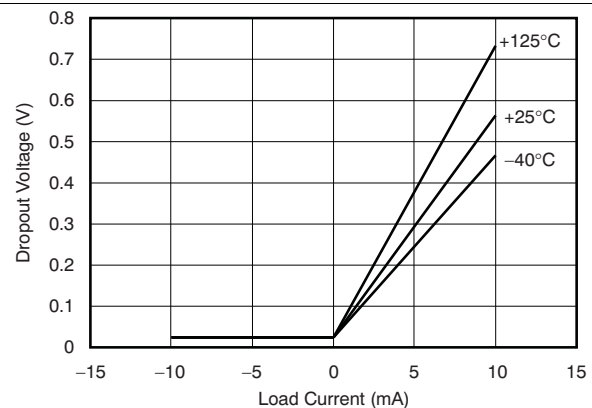


Figure 6. Dropout Voltage vs Load Current



## Typical Characteristics (continued)

At  $T_A = 25^\circ\text{C}$ ,  $I_{\text{LOAD}} = 0$ , and  $V_S = V_{\text{OUT}} + 0.2\text{ V}$ , unless otherwise noted. For  $V_{\text{OUT}} \leq 2.5\text{ V}$ , the minimum supply voltage is 2.7 V.

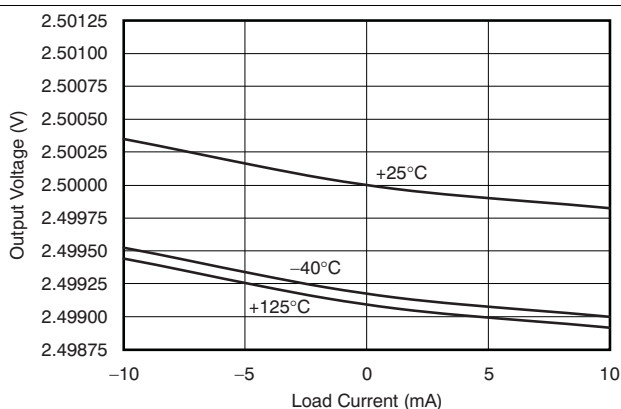


Figure 7. REF5025 Output Voltage vs Load Current

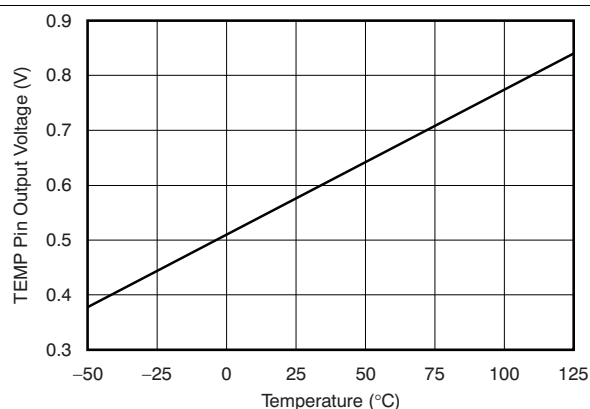


Figure 8. Temp Pin Output Voltage vs Temperature

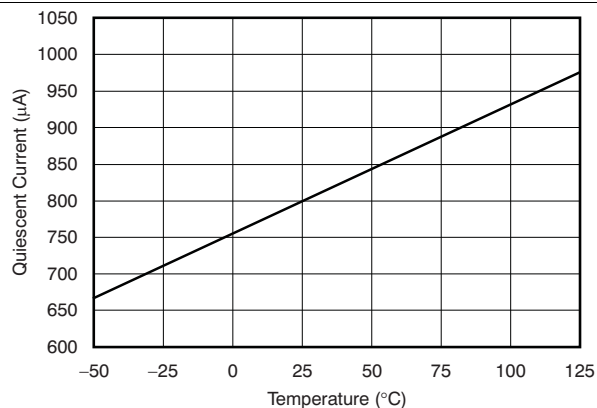


Figure 9. Quiescent Current vs Temperature

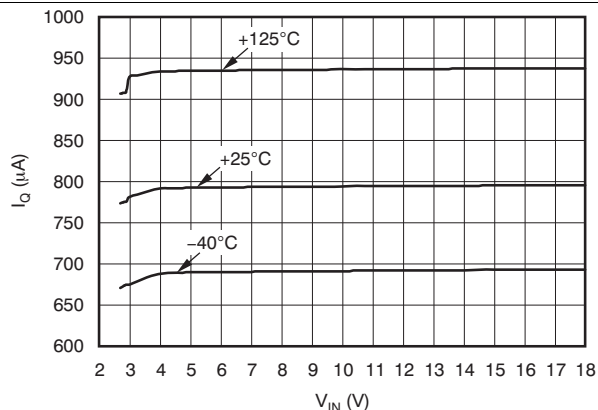


Figure 10. Quiescent Current vs Input Voltage

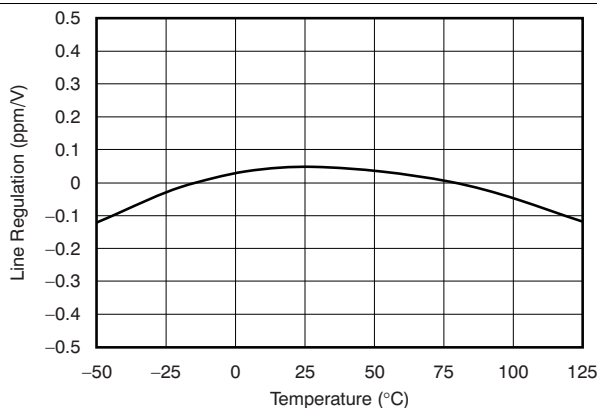


Figure 11. Line Regulation vs Temperature

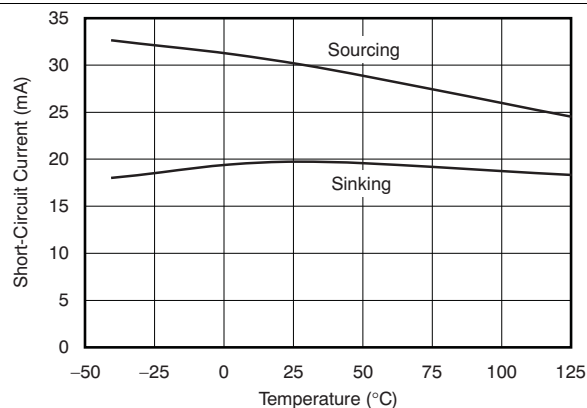


Figure 12. Short Circuit Current vs Temperature

## Typical Characteristics (continued)

At  $T_A = 25^\circ\text{C}$ ,  $I_{\text{LOAD}} = 0$ , and  $V_S = V_{\text{OUT}} + 0.2\text{ V}$ , unless otherwise noted. For  $V_{\text{OUT}} \leq 2.5\text{ V}$ , the minimum supply voltage is 2.7 V.

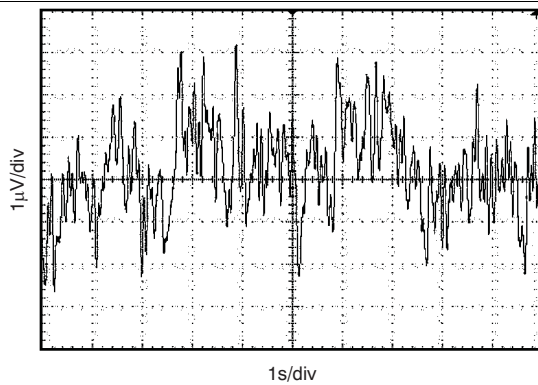


Figure 13. NOISE

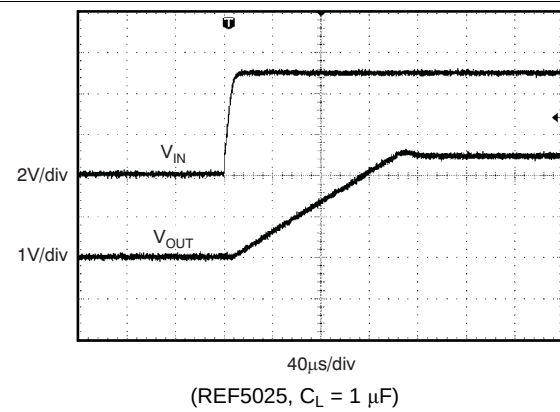


Figure 14. Start-Up

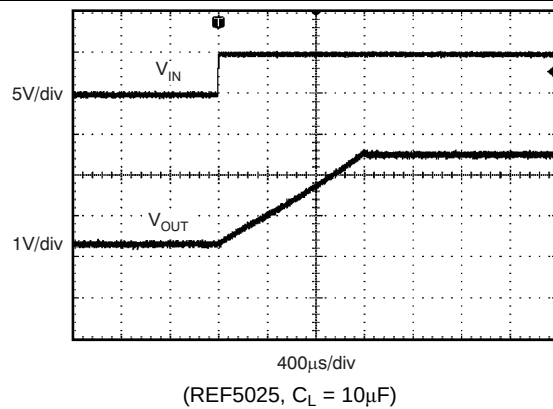


Figure 15. Start-Up

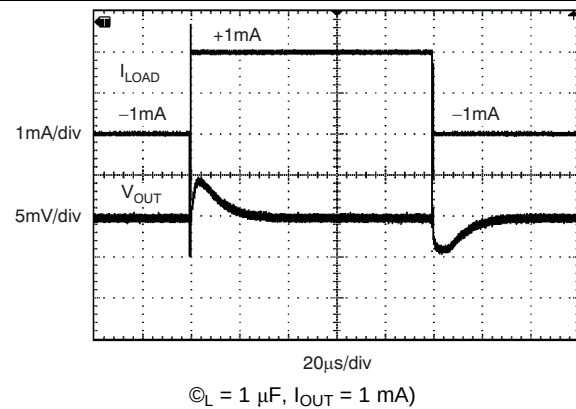


Figure 16. Load Transient

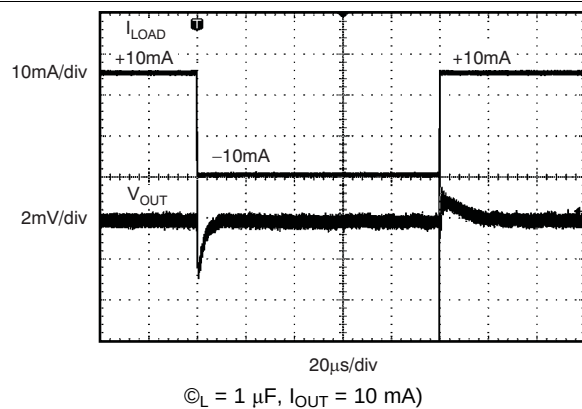


Figure 17. Load Transient

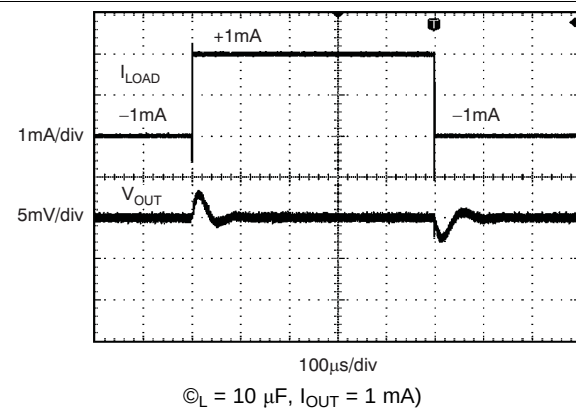


Figure 18. Load Transient

## Typical Characteristics (continued)

At  $T_A = 25^\circ\text{C}$ ,  $I_{\text{LOAD}} = 0$ , and  $V_S = V_{\text{OUT}} + 0.2\text{ V}$ , unless otherwise noted. For  $V_{\text{OUT}} \leq 2.5\text{ V}$ , the minimum supply voltage is 2.7 V.

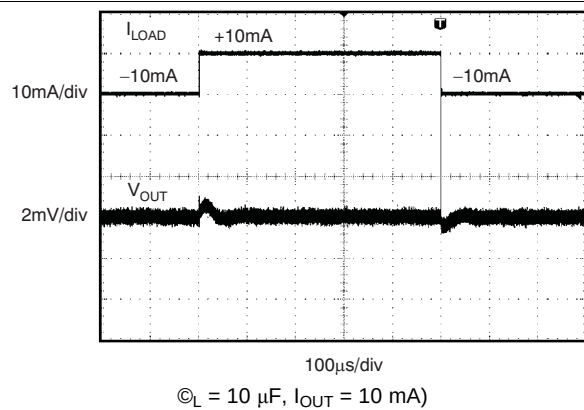


Figure 19. Load Transient

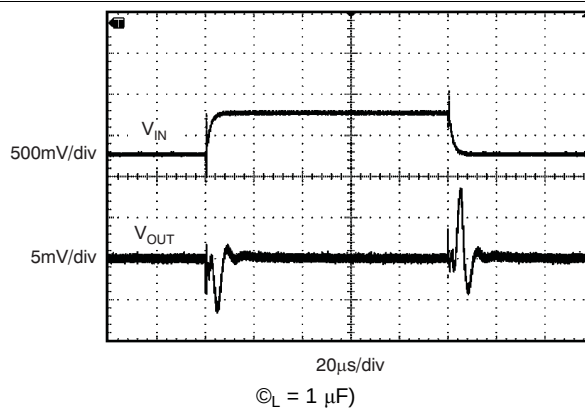


Figure 20. Line Transient

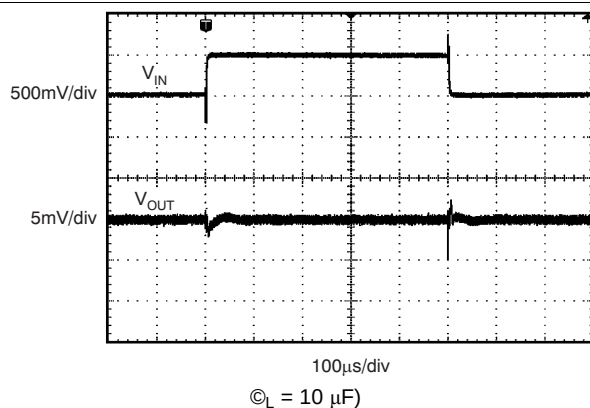


Figure 21. Line Transient

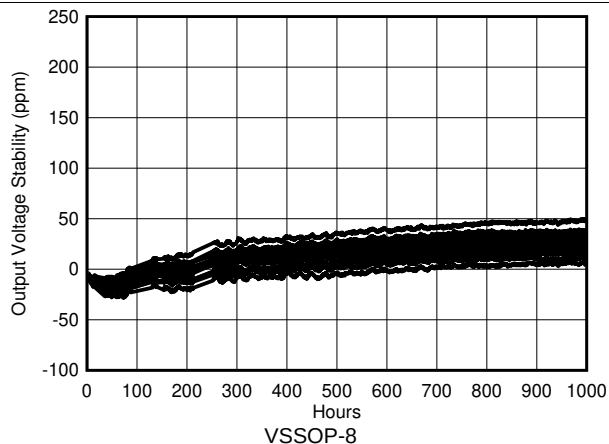


Figure 22. REF50xx Long-Term Stability (First 1000 Hours)

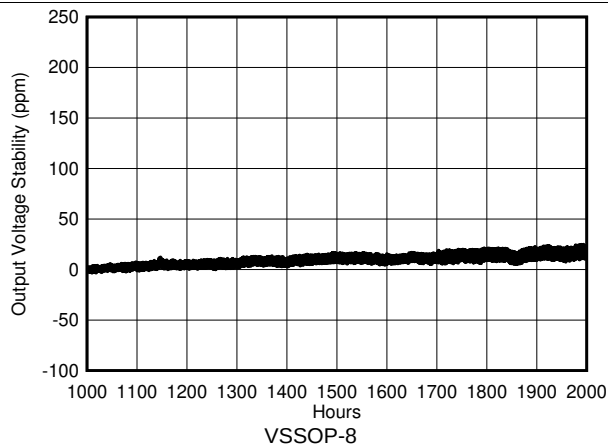


Figure 23. REF50xx Long-Term Stability  
(Second 1000 Hours)

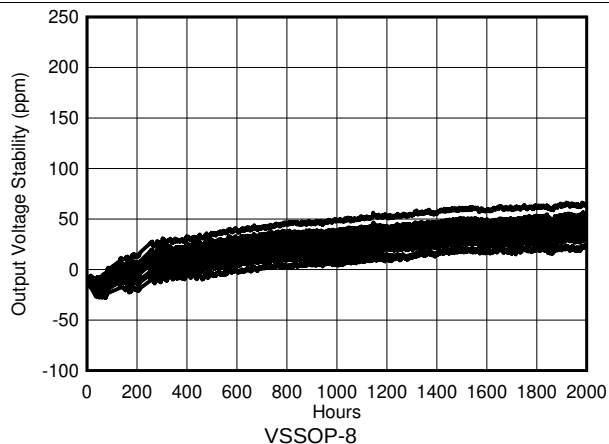


Figure 24. REF50xx Long-Term Stability (First 2000 Hours)

## Typical Characteristics (continued)

At  $T_A = 25^\circ\text{C}$ ,  $I_{\text{LOAD}} = 0$ , and  $V_S = V_{\text{OUT}} + 0.2\text{ V}$ , unless otherwise noted. For  $V_{\text{OUT}} \leq 2.5\text{ V}$ , the minimum supply voltage is 2.7 V.

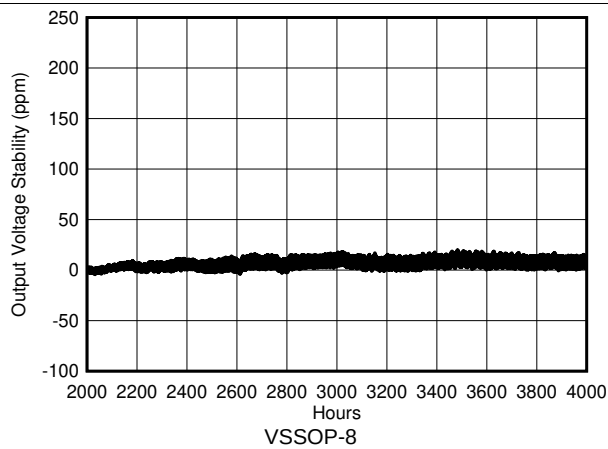


Figure 25. REF50xx Long-Term Stability (Second 2000 Hours)

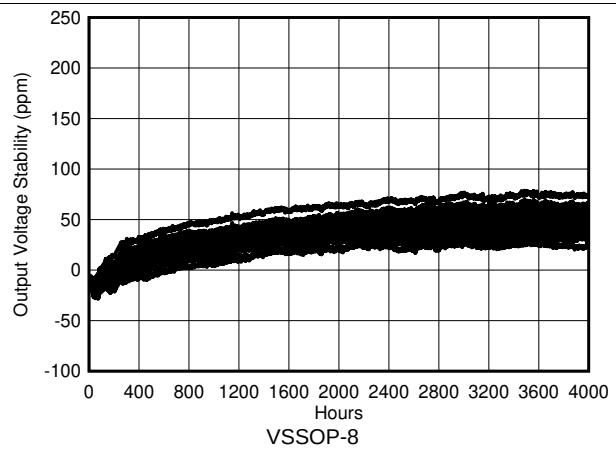


Figure 26. REF50xx Long-Term Stability (4000 Hours)

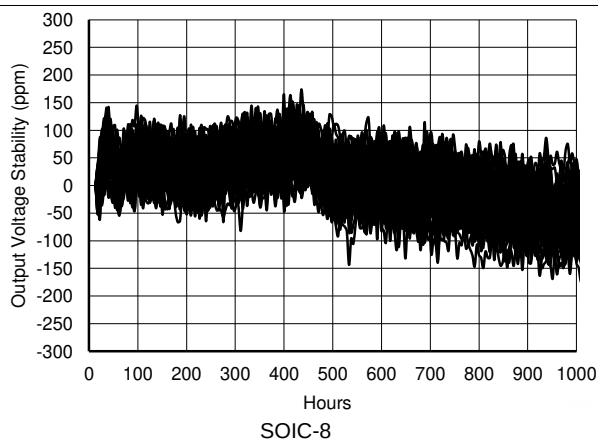


Figure 27. REF50xx Long-Term Stability (First 1000 Hours)

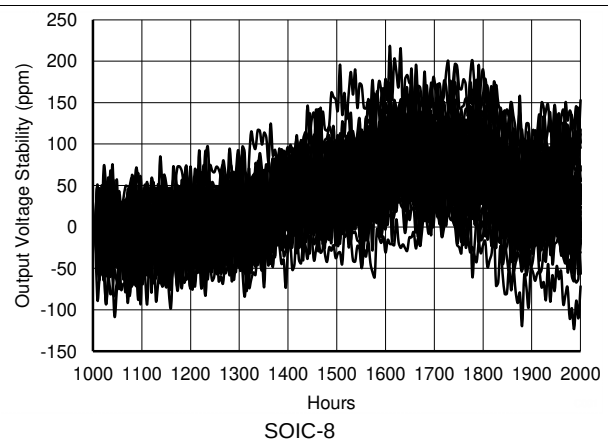


Figure 28. REF50xx Long-Term Stability (Second 1000 Hours)

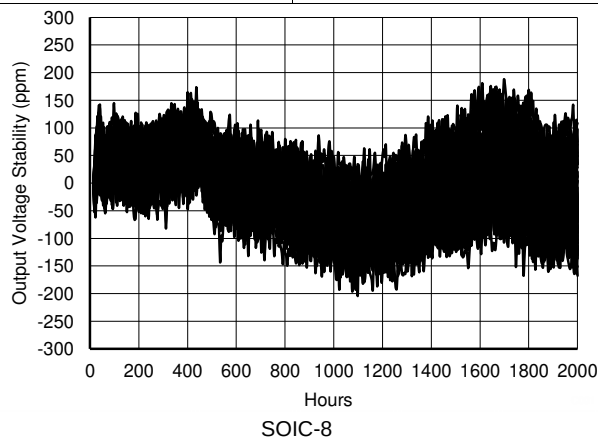


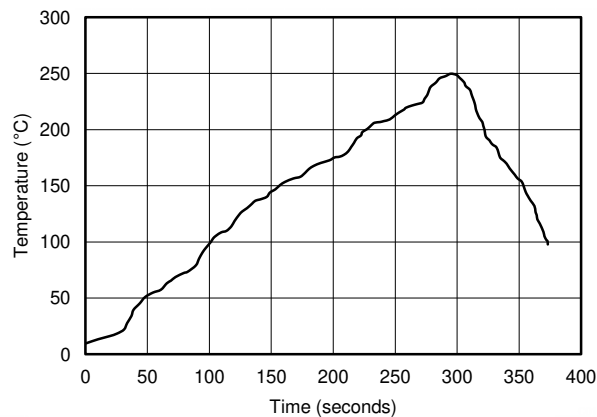
Figure 29. REF50xx Long-Term Stability (2000 Hours)

## 8 Parameter Measurement Information

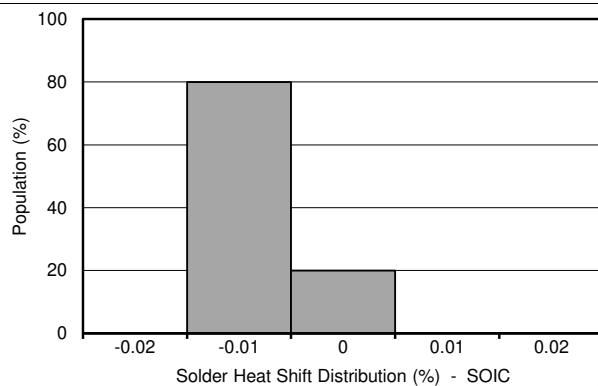
**Solder Heat Shift** The materials used in the manufacture of the REF50xx have differing coefficients of thermal expansion, resulting in stress on the device die when the part is heated. Mechanical and thermal stress on the device can cause the output voltages to shift, degrading the initial accuracy and drift specifications of the product. Reflow soldering is a common cause of this error.

To illustrate this effect, a total of 36 devices were soldered on printed-circuit-boards using lead-free solder paste and the paste manufacturer suggested reflow profile. The reflow profile is as shown in [Figure 30](#). The printed-circuit-board is comprised of FR4 material. The board thickness is 0.8 mm and the area is 13 mm × 13 mm.

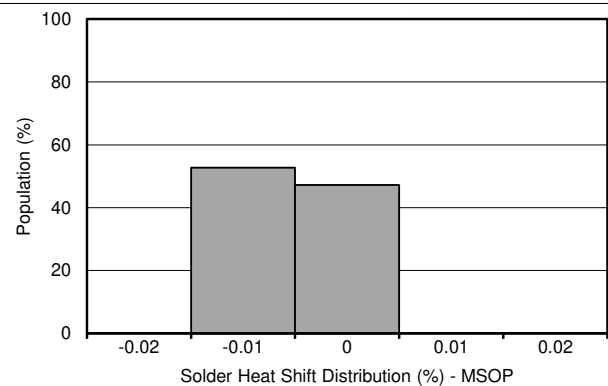
The reference voltage is measured before and after the reflow process across temperature; the typical shift of accuracy and drift is displayed in [Figure 31](#) through [Figure 38](#). Although all tested units exhibit very low shifts, higher shifts are also possible depending on the size, thickness, and material of the printed-circuit-board. An important note is that the histograms display the typical shift for exposure to a single reflow profile. Exposure to multiple reflows, as is common on printed circuit boards (PCBs) with surface-mount components on both sides, causes additional shifts in the output bias voltage. If the PCB is exposed to multiple reflows, then solder the device in the last pass to minimize device exposure to thermal stress.



**Figure 30. Reflow Profile**

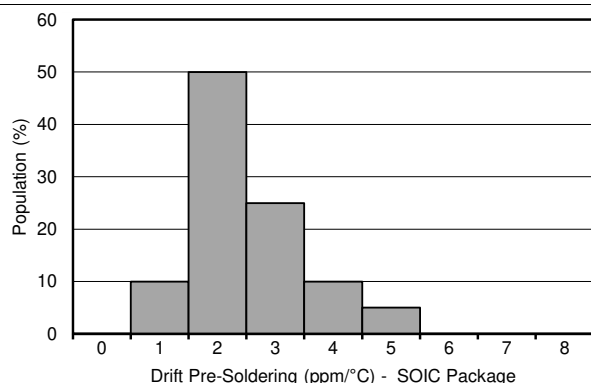


**Figure 31. Solder Heat Shift Distribution (%), SOIC Package**

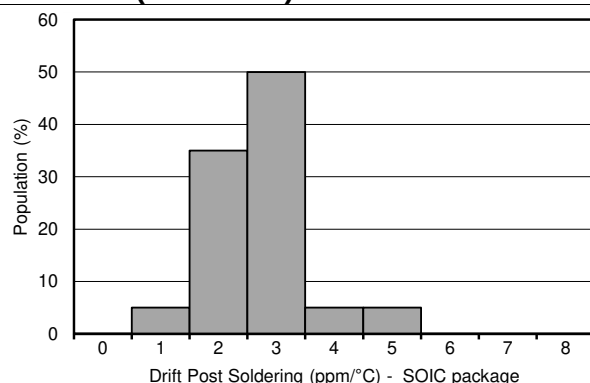


**Figure 32. Solder Heat Shift Distribution (%), VSSOP Package**

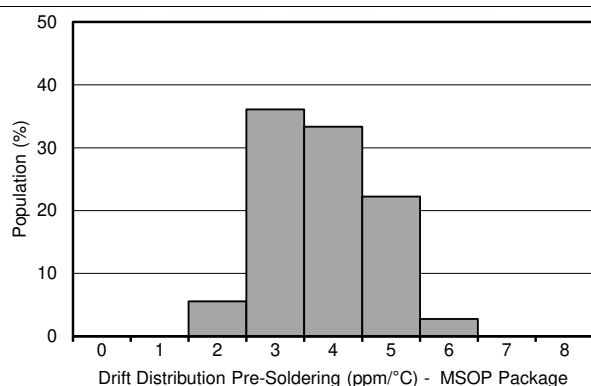
## Parameter Measurement Information (continued)



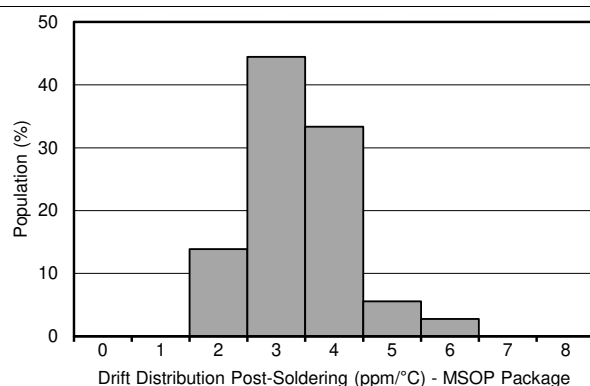
**Figure 33. Drift Pre-Soldering Distribution, SOIC Package**



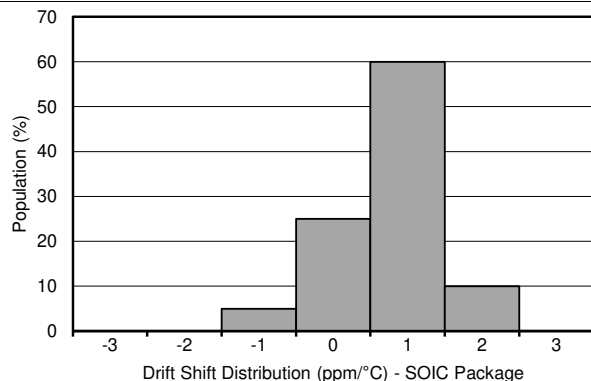
**Figure 34. Drift Post Soldering Distribution, SOIC Package**



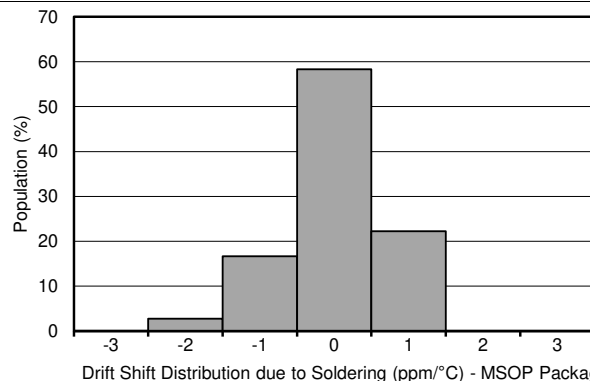
**Figure 35. Drift Distribution Pre-Soldering, VSSOP Package**



**Figure 36. Drift Distribution Post-Soldering, VSSOP Package**



**Figure 37. Drift Shift Distribution, SOIC Package**



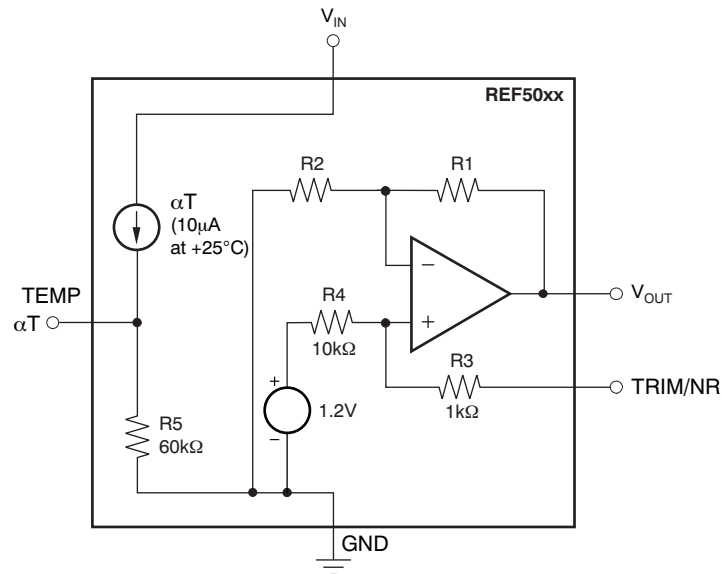
**Figure 38. Drift Shift Distribution, VSSOP Package**

## 9 Detailed Description

### 9.1 Overview

The REF50xx is family of low-noise, precision bandgap voltage references that are specifically designed for excellent initial voltage accuracy and drift. See the [Functional Block Diagram](#) for a simplified block diagram of the REF50xx.

### 9.2 Functional Block Diagram



## 9.3 Feature Description

### 9.3.1 Temperature Monitoring

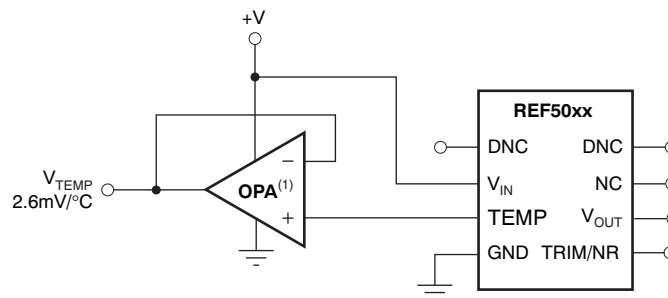
The temperature output terminal (TEMP, pin 3) provides a temperature-dependent voltage output with approximately 60-kΩ source impedance. As illustrated in Figure 8, the output voltage follows the nominal relationship:

$$V_{\text{TEMP PIN}} = 509 \text{ mV} + 2.64 \times T(^{\circ}\text{C}) \quad (1)$$

This pin indicates general chip temperature, accurate to approximately  $\pm 15^{\circ}\text{C}$ . Although not generally suitable for accurate temperature measurements, this pin can be used to indicate temperature changes or for temperature compensation of analog circuitry. A temperature change of  $30^{\circ}\text{C}$  corresponds to an approximate 79-mV change in voltage at the TEMP pin.

The TEMP pin has high-output impedance (see the [Functional Block Diagram](#)). Loading this pin with a low-impedance circuit induces a measurement error; however, this pin does not have any effect on  $V_{\text{OUT}}$  accuracy.

To avoid errors caused by low-impedance loading, buffer the TEMP pin output with a suitable low-temperature drift op amp, such as the OPA333, OPA335, or OPA376, as shown in Figure 39.



NOTE: (1) Low drift op amp, such as the OPA333, OPA335, or OPA376.

**Figure 39. Buffering the TEMP Pin Output**

### 9.3.2 Temperature Drift

The REF50xx is designed for minimal drift error, which is defined as the change in output voltage over temperature. The drift is calculated using the box method, as described in Equation 2.

$$\text{Drift} = \left( \frac{V_{\text{OUTMAX}} - V_{\text{OUTMIN}}}{V_{\text{OUT}} \times \text{Temp Range}} \right) \times 10^6 (\text{ppm}) \quad (2)$$

The REF50xx features a maximum drift coefficient of 3 ppm/ $^{\circ}\text{C}$  for the high-grade version, and 8 ppm/ $^{\circ}\text{C}$  for the standard-grade.

### 9.3.3 Thermal Hysteresis

Thermal hysteresis for the REF50xx is defined as the change in output voltage after operating the device at  $25^{\circ}\text{C}$ , cycling the device through the specified temperature range, and returning to  $25^{\circ}\text{C}$ . Thermal hysteresis can be expressed as Equation 3:

$$V_{\text{HYST}} = \left( \frac{|V_{\text{PRE}} - V_{\text{POST}}|}{V_{\text{NOM}}} \right) \cdot 10^6 (\text{ppm})$$

where

- $V_{\text{HYST}}$  = thermal hysteresis (in units of ppm).
- $V_{\text{NOM}}$  = the specified output voltage.
- $V_{\text{PRE}}$  = output voltage measured at  $25^{\circ}\text{C}$  pretemperature cycling.
- $V_{\text{POST}}$  = output voltage measured after the device has been cycled from  $25^{\circ}\text{C}$  through the specified temperature range of  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$  and returned to  $25^{\circ}\text{C}$ .

(3)



## Feature Description (continued)

### 9.3.4 Noise Performance

Typical 0.1-Hz to 10-Hz voltage noise for each member of the REF50xx family is specified in the [Electrical Characteristics](#) table. The noise voltage increases with output voltage and operating temperature. Additional filtering can be used to improve output noise levels, although take care to ensure the output impedance does not degrade performance.

For additional information about how to minimize noise and maximize performance in mixed-signal applications such as data converters, refer to the series of *Analog Applications Journal* articles entitled, *How a Voltage Reference Affects ADC Performance*. This three-part series is available for download from the TI website under three literature numbers: [SLYT331](#), [SLYT339](#), and [SLYT355](#) for [Part I](#), [Part II](#), and [Part III](#), respectively.

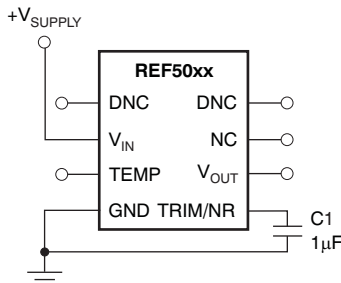


Figure 40. Noise Reduction Using the TRIM/NR Pin

### 9.3.5 Long-Term Stability

Due to aging and environmental effects, all semiconductor devices experience physical changes of the semiconductor die and the packaging material over time. These changes and the associated package stress on the die cause the output voltage in precision voltage references to deviate over time. The value of such change is specified on the datasheet by a parameter called the Long-term stability (also known as the Long-Term Drift (LTD)). [Equation 4](#) shows how LTD is calculated. Note that the LTD value will be positive if the output voltage drifts higher over time, negative if the voltage drifts lower over time. [Figures 22 to 29](#) of the REF50xx datasheet show the drift of the output voltage for REF50xx over the first 4000 operating hours.

$$\text{LTD}(\text{ppm})|_{t=n} = \frac{(V_{\text{OUT}}|_{t=0} - V_{\text{OUT}}|_{t=n})}{V_{\text{OUT}}|_{t=0}} \times 10^6$$

where

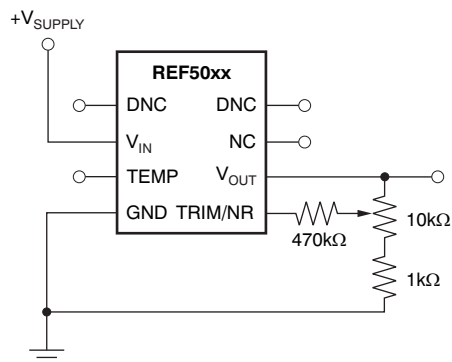
- $\text{LTD}(\text{ppm})|_{t=n}$  = Long-term stability (in units of ppm).
- $V_{\text{OUT}}|_{t=0}$  = Output voltage at time = 0 hr.
- $V_{\text{OUT}}|_{t=n}$  = Output voltage at time = n hr.

(4)

### 9.3.6 Output Adjustment Using the TRIM/NR Pin

The REF50xx provides a very accurate, factory-trimmed voltage output. However,  $V_{\text{OUT}}$  can be adjusted using the trim and noise reduction pin (TRIM/NR, pin 5). [Figure 41](#) shows a typical circuit that allows an output adjustment of  $\pm 15\text{mV}$ .

## Feature Description (continued)



**Figure 41. V<sub>OUT</sub> Adjustment Using the TRIM/NR Pin**

The REF50xx allows access to the bandgap through the TRIM/NR pin. Placing a capacitor from the TRIM/NR pin to GND (Figure 40) in combination with the internal  $R_3$  and  $R_4$  resistors creates a low-pass filter. A capacitance of  $1\mu\text{F}$  creates a low-pass filter with the corner frequency from 10 Hz to 20 Hz. Such a filter decreases the overall noise measured on the  $V_{\text{OUT}}$  pin by half. Higher capacitance results in a lower filter cutoff frequency, further reducing output noise. Using this capacitor increases start-up time.

## 9.4 Device Functional Modes

### 9.4.1 Basic Connections

Figure 42 shows the typical connections for the REF50xx. TI recommends a supply bypass capacitor ranging from 1  $\mu$ F to 10  $\mu$ F. A 1- $\mu$ F to 50- $\mu$ F output capacitor ( $C_L$ ) must be connected from  $V_{OUT}$  to GND. The equivalent series resistance (ESR) value of  $C_L$  must be less than or equal to 1.5  $\Omega$  to ensure output stability. To minimize noise, the recommended ESR of  $C_L$  is from 1  $\Omega$  and 1.5  $\Omega$ .

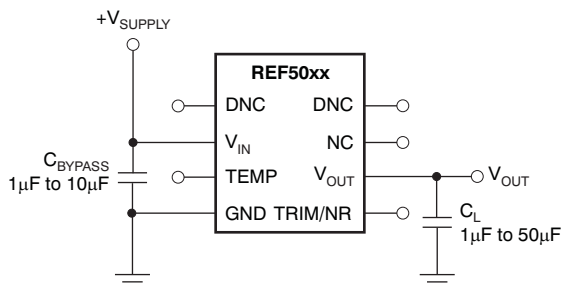


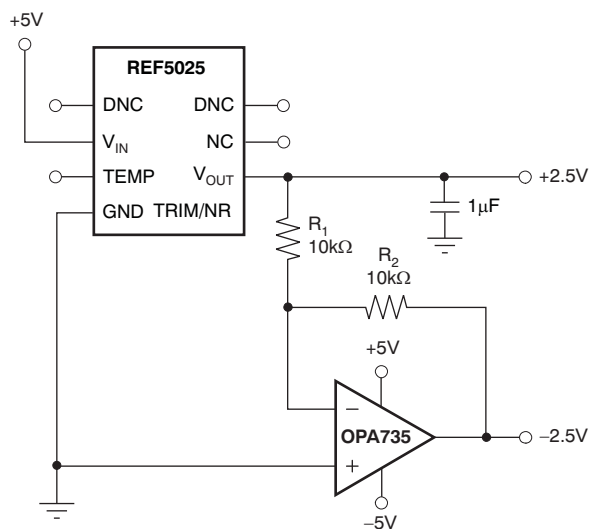
Figure 42. Basic Connections

### 9.4.2 Supply Voltage

The REF50xx family of voltage references features extremely low dropout voltage. With the exception of the REF5020, which has a minimum supply requirement of 2.7 V, these references can be operated with a supply of 200 mV more than the output voltage in an unloaded condition. For loaded conditions, a typical dropout voltage versus load plot is provided in Figure 6 in the *Typical Characteristics*.

### 9.4.3 Negative Reference Voltage

For applications requiring a negative and positive reference voltage, the REF50xx and OPA735 can be used to provide a dual-supply reference from a 5-V supply. Figure 43 shows the REF5025 used to provide a 2.5-V supply reference voltage. The low drift performance of the REF50xx complements the low offset voltage and zero drift of the OPA735 to provide an accurate solution for split-supply applications. Take care to match the temperature coefficients of  $R_1$  and  $R_2$ .



NOTE: Bypass capacitors not shown.

Figure 43. The REF5025 and OPA735 Create Positive and Negative Reference Voltages

## 10 Applications and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 10.1 Application Information

Data acquisition systems often require stable voltage references to maintain accuracy. The REF50xx family features low noise, very low drift, and high initial accuracy for high-performance data converters. Figure 44 shows the REF5040 in a basic data acquisition system.

### 10.2 Typical Applications

#### 10.2.1 16-bit, 250-KSPS Data Acquisition System

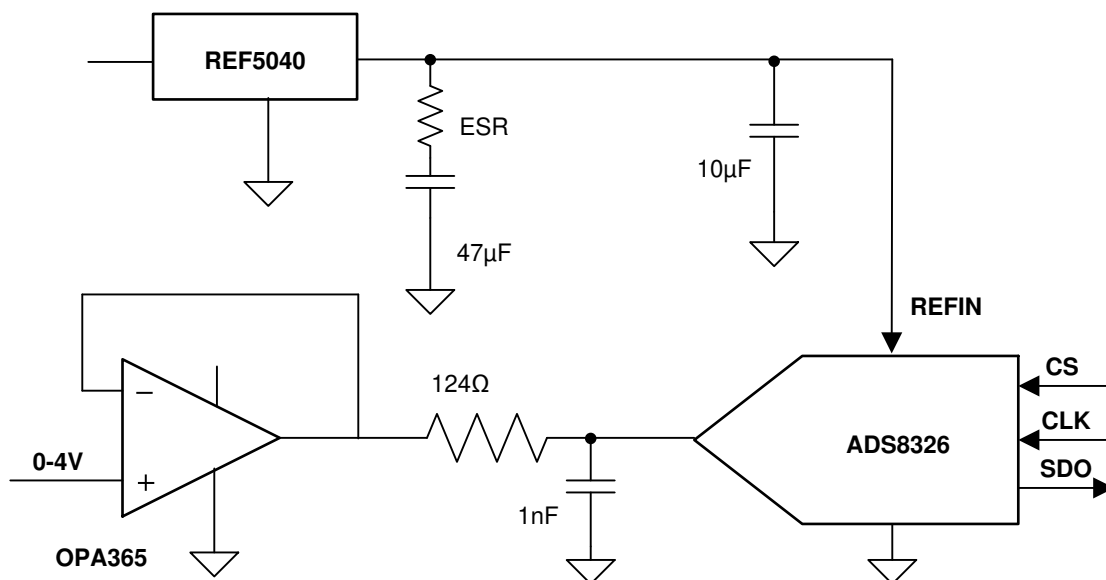


Figure 44. Complete Data Acquisition System Using REF50xx

##### 10.2.1.1 Design Requirements

When using the REF50xx in the design, select a proper output capacitor that does not create gain peaking, thereby increasing total system noise. At the same time, the capacitor must be selected to provide required filtering performance for the system. In addition, input bypass capacitor and noise reduction capacitors must be added for optimum performances. During the design of the data acquisition system, equal consideration must be given to the buffering analog input signal as well as the reference voltage. Having a properly designed input buffer with an associated RC filter is a necessary requirement for good performance of the Data Acquisition System.

##### 10.2.1.2 Detailed Design Procedure

The OPA365 is used to drive the 16-bit Analog to Digital Converter (ADS8326). The RC filter at the output of the OPA365 is used to reduce the charge kick-back created by the opening and closing of the sampling switch inside the ADC. Design the RC filter such that the voltage at the sampling capacitor settles to 16-bit accuracy within the acquisition time of the ADC. The bandwidth of the driving amplifier must at least be 4 times the bandwidth of the RC filter.

## Typical Applications (continued)

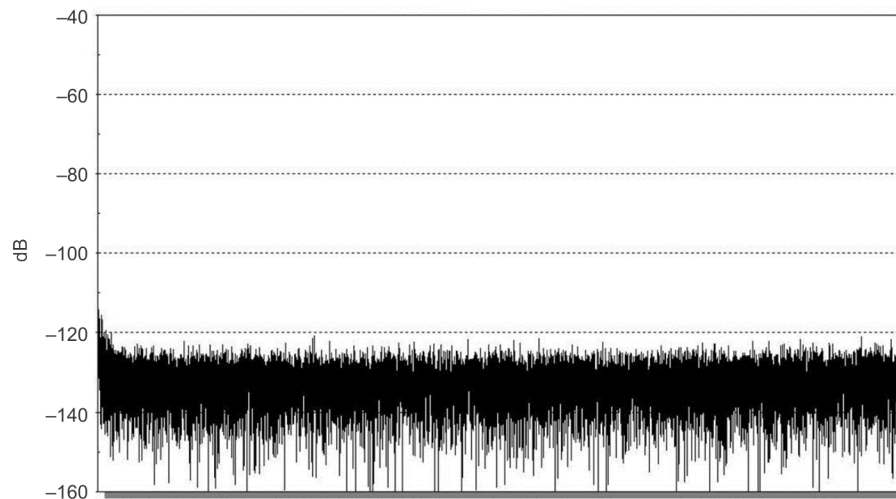
The REF5040 is used to drive the REF pin of the ADS8326. Proper selection of Voltage Reference output capacitor is very important for this design. Very Low equivalent series resistance (ESR) creates gain-peaking which degrades SNR of the total system. If the ESR of the capacitor is not enough, then an additional resistor must be added in series with the output capacitor. A capacitance of 1  $\mu\text{F}$  can be connected to the NR pin to reduce bandgap noise of the REF50xx.

SNR Measurements using different RC filters at the output of OPA365, different values of output capacitor for the REF50xx and different values of capacitors at the TRIM/NR pin are shown in [Table 1](#).

**Table 1. Data Acquisition Measurement Results for Different Conditions**

|                          | TEST CONDITION 1    | TEST CONDITION 2                    |
|--------------------------|---------------------|-------------------------------------|
| OPA365 RC filter         | 124 $\Omega$ , 1 nF | 124 $\Omega$ , 1 nF                 |
| REF5040 Output capacitor | 10 $\mu\text{F}$    | 10 $\mu\text{F}$ + 47 $\mu\text{F}$ |
| TRIM /NR pin capacitor   | 0 $\mu\text{F}$     | 1 $\mu\text{F}$                     |
| SNR                      | 86.7 dB             | 92.8 dB                             |

### 10.2.1.3 Application Curve



**Figure 45. FFT plot- Noise floor of Data Acquisition system**

## 11 Power Supply Recommendations

The REF50xx family of voltage references features extremely low dropout voltage. With the exception of the REF5020, which has a minimum supply requirement of 2.7 V, these references can be operated with a supply of 200 mV more than the output voltage in an unloaded condition. For loaded conditions, a typical dropout voltage versus load plot is provided in [Figure 6](#) in the *Typical Characteristics*. TI recommends a supply bypass capacitor ranging from 1 µF to 50 µF.

## 12 Layout

### 12.1 Layout Guidelines

- Place the power-supply bypass capacitor as closely as possible to the supply and ground pins. The recommended value of this bypass capacitor is from 1 µF to 10 µF. If necessary, additional decoupling capacitance can be added to compensate for noisy or high-impedance power supplies.
- Place a 1-µF noise filtering capacitor between the NR pin and ground.
- The output must be decoupled with a 1-µF to 50-µF capacitor. A resistor in series with the output capacitor is optional. For better noise performance, the recommended ESR on the output capacitor is from 1 Ω to 1.5 Ω.
- A high-frequency, 1-µF capacitor can be added in parallel between the output and ground to filter noise and help with switching loads as data converters.

### 12.2 Layout Example

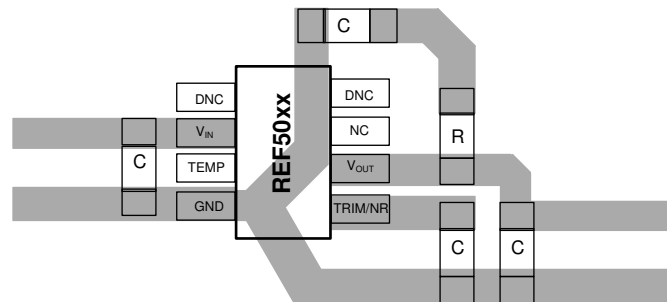


Figure 46. Layout Example

### 12.3 Power Dissipation

The REF50xx family is specified to deliver current loads of ±10 mA over the specified input voltage range. The temperature of the device increases according to [Equation 5](#):

$$T_J = T_A + P_D \times \theta_{JA}$$

where

- $T_J$  = Junction temperature (°C)
  - $T_A$  = Ambient temperature (°C)
  - $P_D$  = Power dissipated (W)
  - $\theta_{JA}$  = Junction-to-ambient thermal resistance (°C/W)
- (5)

The REF50xx junction temperature must not exceed the absolute maximum rating of 150°C.

## 13 Device and Documentation Support

### 13.1 Documentation Support

#### 13.1.1 Related Documentation

For related documentation see the following:

- 0.05uV/degC (max), Single-Supply CMOS Zero-Drift Series Operational Amplifier, [SBOS282](#).
- REF5020 PSpice Model, [SLIM160](#).
- REF5020 TINA-TI Reference Design, [SLIM159](#).
- REF5020 TINA-TI Spice Model, [SLIM158](#).
- INA270 PSpice Model, [SBOM485](#).
- INA270 TINA-TI Reference Design, [SBOM246](#).
- INA270 TINA-TI Spice Model, [SBOM306](#).

### 13.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

**Table 2. Related Links**

| PARTS   | PRODUCT FOLDER             | SAMPLE & BUY               | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|---------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| REF5010 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| REF5020 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| REF5025 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| REF5030 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| REF5040 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| REF5045 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| REF5050 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

### 13.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](http://ti.com). In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 13.4 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### 13.5 Trademarks

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

### 13.6 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 13.7 Glossary

[SLYZ022](#) — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

## 14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| REF5010AID       | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5010<br>A        | <a href="#">Samples</a> |
| REF5010AIDGKR    | ACTIVE        | VSSOP        | DGK                | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | R50G                    | <a href="#">Samples</a> |
| REF5010AIDGKT    | ACTIVE        | VSSOP        | DGK                | 8    | 250            | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | R50G                    | <a href="#">Samples</a> |
| REF5010AIDR      | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5010<br>A        | <a href="#">Samples</a> |
| REF5010ID        | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5010             | <a href="#">Samples</a> |
| REF5010IDGKR     | ACTIVE        | VSSOP        | DGK                | 8    | 2500           | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | R50G                    | <a href="#">Samples</a> |
| REF5010IDGKT     | ACTIVE        | VSSOP        | DGK                | 8    | 250            | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | R50G                    | <a href="#">Samples</a> |
| REF5020AID       | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5020<br>A        | <a href="#">Samples</a> |
| REF5020AIDG4     | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5020<br>A        | <a href="#">Samples</a> |
| REF5020AIDGKR    | ACTIVE        | VSSOP        | DGK                | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | R50A                    | <a href="#">Samples</a> |
| REF5020AIDGKT    | ACTIVE        | VSSOP        | DGK                | 8    | 250            | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | R50A                    | <a href="#">Samples</a> |
| REF5020AIDR      | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5020<br>A        | <a href="#">Samples</a> |
| REF5020AIDRG4    | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5020<br>A        | <a href="#">Samples</a> |
| REF5020ID        | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5020             | <a href="#">Samples</a> |
| REF5020IDGKR     | ACTIVE        | VSSOP        | DGK                | 8    | 2500           | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | R50A                    | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| REF5020IDGKT     | ACTIVE        | VSSOP        | DGK                | 8    | 250            | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | R50A                    | <a href="#">Samples</a> |
| REF5020IDR       | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5020             | <a href="#">Samples</a> |
| REF5020IDRG4     | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5020             | <a href="#">Samples</a> |
| REF5025AID       | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5025<br>A        | <a href="#">Samples</a> |
| REF5025AIDG4     | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5025<br>A        | <a href="#">Samples</a> |
| REF5025AIDGKR    | ACTIVE        | VSSOP        | DGK                | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | R50B                    | <a href="#">Samples</a> |
| REF5025AIDGKT    | ACTIVE        | VSSOP        | DGK                | 8    | 250            | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | R50B                    | <a href="#">Samples</a> |
| REF5025AIDR      | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5025<br>A        | <a href="#">Samples</a> |
| REF5025AIDRG4    | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5025<br>A        | <a href="#">Samples</a> |
| REF5025ID        | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5025             | <a href="#">Samples</a> |
| REF5025IDG4      | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5025             | <a href="#">Samples</a> |
| REF5025IDGKR     | ACTIVE        | VSSOP        | DGK                | 8    | 2500           | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | R50B                    | <a href="#">Samples</a> |
| REF5025IDGKT     | ACTIVE        | VSSOP        | DGK                | 8    | 250            | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | R50B                    | <a href="#">Samples</a> |
| REF5025IDR       | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5025             | <a href="#">Samples</a> |
| REF5025IDRG4     | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5025             | <a href="#">Samples</a> |
| REF5030AID       | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5030<br>A        | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| REF5030AIDG4     | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5030<br>A        | <a href="#">Samples</a> |
| REF5030AIDGKR    | ACTIVE        | VSSOP        | DGK                | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | R50C                    | <a href="#">Samples</a> |
| REF5030AIDGKT    | ACTIVE        | VSSOP        | DGK                | 8    | 250            | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | R50C                    | <a href="#">Samples</a> |
| REF5030AIDR      | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5030<br>A        | <a href="#">Samples</a> |
| REF5030ID        | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5030             | <a href="#">Samples</a> |
| REF5030IDGKR     | ACTIVE        | VSSOP        | DGK                | 8    | 2500           | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | R50C                    | <a href="#">Samples</a> |
| REF5030IDGKT     | ACTIVE        | VSSOP        | DGK                | 8    | 250            | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | R50C                    | <a href="#">Samples</a> |
| REF5030IDR       | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5030             | <a href="#">Samples</a> |
| REF5040AID       | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5040<br>A        | <a href="#">Samples</a> |
| REF5040AIDG4     | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5040<br>A        | <a href="#">Samples</a> |
| REF5040AIDGKR    | ACTIVE        | VSSOP        | DGK                | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | R50D                    | <a href="#">Samples</a> |
| REF5040AIDGKT    | ACTIVE        | VSSOP        | DGK                | 8    | 250            | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | R50D                    | <a href="#">Samples</a> |
| REF5040AIDR      | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5040<br>A        | <a href="#">Samples</a> |
| REF5040ID        | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5040             | <a href="#">Samples</a> |
| REF5040IDG4      | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5040             | <a href="#">Samples</a> |
| REF5040IDGKR     | ACTIVE        | VSSOP        | DGK                | 8    | 2500           | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | R50D                    | <a href="#">Samples</a> |
| REF5040IDGKT     | ACTIVE        | VSSOP        | DGK                | 8    | 250            | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | R50D                    | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| REF5040IDR       | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5040             | <a href="#">Samples</a> |
| REF5040IDRG4     | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5040             | <a href="#">Samples</a> |
| REF5045AID       | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5045<br>A        | <a href="#">Samples</a> |
| REF5045AIDG4     | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5045<br>A        | <a href="#">Samples</a> |
| REF5045AIDGKR    | ACTIVE        | VSSOP        | DGK                | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | R50E                    | <a href="#">Samples</a> |
| REF5045AIDGKT    | ACTIVE        | VSSOP        | DGK                | 8    | 250            | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | R50E                    | <a href="#">Samples</a> |
| REF5045AIDR      | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5045<br>A        | <a href="#">Samples</a> |
| REF5045ID        | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5045             | <a href="#">Samples</a> |
| REF5045IDGKR     | ACTIVE        | VSSOP        | DGK                | 8    | 2500           | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | R50E                    | <a href="#">Samples</a> |
| REF5045IDGKT     | ACTIVE        | VSSOP        | DGK                | 8    | 250            | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | R50E                    | <a href="#">Samples</a> |
| REF5045IDR       | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5045             | <a href="#">Samples</a> |
| REF5050AID       | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5050<br>A        | <a href="#">Samples</a> |
| REF5050AIDG4     | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5050<br>A        | <a href="#">Samples</a> |
| REF5050AIDGKR    | ACTIVE        | VSSOP        | DGK                | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | R50F                    | <a href="#">Samples</a> |
| REF5050AIDGKT    | ACTIVE        | VSSOP        | DGK                | 8    | 250            | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | R50F                    | <a href="#">Samples</a> |
| REF5050AIDR      | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5050<br>A        | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| REF5050ID        | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5050             | <a href="#">Samples</a> |
| REF5050IDG4      | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5050             | <a href="#">Samples</a> |
| REF5050IDGKR     | ACTIVE        | VSSOP        | DGK                | 8    | 2500           | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | R50F                    | <a href="#">Samples</a> |
| REF5050IDGKT     | ACTIVE        | VSSOP        | DGK                | 8    | 250            | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | R50F                    | <a href="#">Samples</a> |
| REF5050IDR       | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5050             | <a href="#">Samples</a> |
| REF5050IDRG4     | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | Call TI                              | Level-2-260C-1 YEAR  | -40 to 125   | REF<br>5050             | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF REF5020, REF5025, REF5040, REF5050 :**

- Enhanced Product : [REF5020-EP](#), [REF5025-EP](#), [REF5040-EP](#), [REF5050-EP](#)

NOTE: Qualified Version Definitions:

- Enhanced Product - Supports Defense, Aerospace and Medical Applications

## TAPE AND REEL INFORMATION



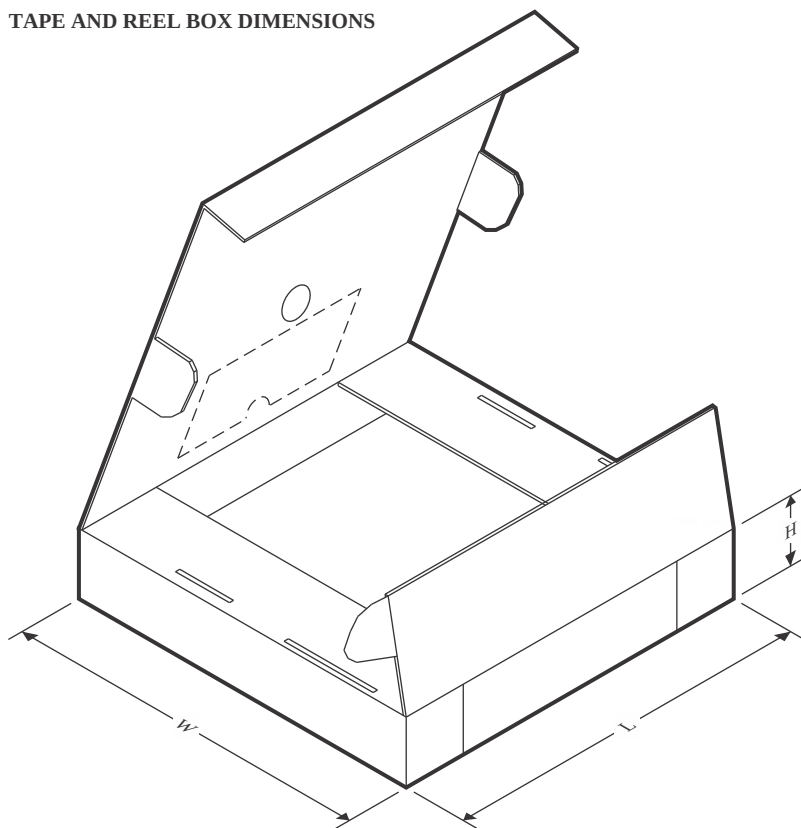
\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| REF5010AIDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5010AIDGKT | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5010AIDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5010IDGKR  | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5010IDGKT  | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5020AIDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5020AIDGKT | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5020AIDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5020IDGKR  | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5020IDGKT  | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5020IDR    | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5025AIDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5025AIDGKT | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5025AIDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5025IDGKR  | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5025IDGKT  | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |

| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| REF5025IDR    | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5030AIDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5030AIDGKT | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5030AIDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5030IDGKR  | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5030IDGKT  | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5030IDR    | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5040AIDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5040AIDGKT | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5040AIDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5040IDGKR  | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5040IDGKT  | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5040IDR    | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5045AIDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5045AIDGKT | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5045AIDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5045IDGKR  | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5045IDGKT  | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5045IDR    | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5050AIDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5050AIDGKT | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5050AIDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5050IDGKR  | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5050IDGKT  | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5050IDR    | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |



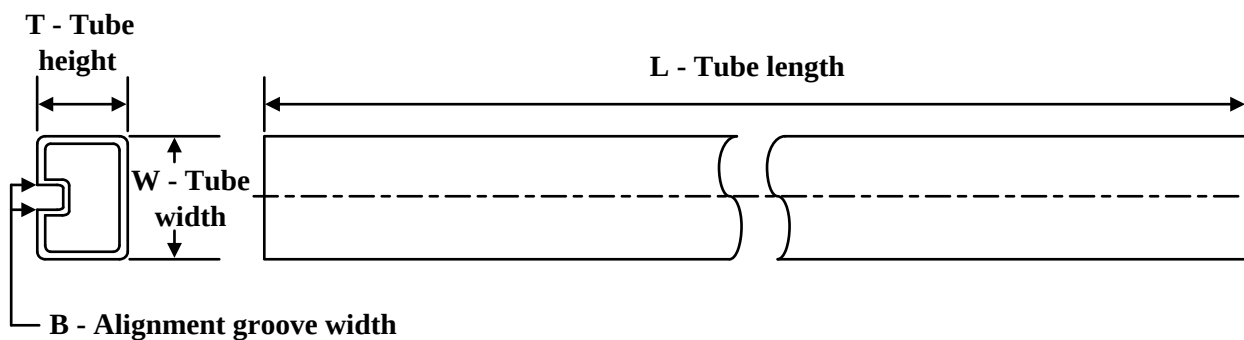
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

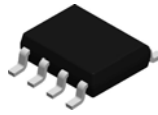
| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| REF5010AIDGKR | VSSOP        | DGK             | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5010AIDGKT | VSSOP        | DGK             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| REF5010AIDR   | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5010IDGKR  | VSSOP        | DGK             | 8    | 2500 | 356.0       | 356.0      | 35.0        |
| REF5010IDGKT  | VSSOP        | DGK             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| REF5020AIDGKR | VSSOP        | DGK             | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5020AIDGKT | VSSOP        | DGK             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| REF5020AIDR   | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5020IDGKR  | VSSOP        | DGK             | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5020IDGKT  | VSSOP        | DGK             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| REF5020IDR    | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5025AIDGKR | VSSOP        | DGK             | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5025AIDGKT | VSSOP        | DGK             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| REF5025AIDR   | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5025IDGKR  | VSSOP        | DGK             | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5025IDGKT  | VSSOP        | DGK             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| REF5025IDR    | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5030AIDGKR | VSSOP        | DGK             | 8    | 2500 | 367.0       | 367.0      | 35.0        |

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| REF5030AIDGKT | VSSOP        | DGK             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| REF5030AIDR   | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5030IDGKR  | VSSOP        | DGK             | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5030IDGKT  | VSSOP        | DGK             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| REF5030IDR    | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5040AIDGKR | VSSOP        | DGK             | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5040AIDGKT | VSSOP        | DGK             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| REF5040AIDR   | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5040IDGKR  | VSSOP        | DGK             | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5040IDGKT  | VSSOP        | DGK             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| REF5040IDR    | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5045AIDGKR | VSSOP        | DGK             | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5045AIDGKT | VSSOP        | DGK             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| REF5045AIDR   | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5045IDGKR  | VSSOP        | DGK             | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| REF5045IDGKT  | VSSOP        | DGK             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| REF5045IDR    | SOIC         | D               | 8    | 2500 | 356.0       | 356.0      | 35.0        |
| REF5050AIDGKR | VSSOP        | DGK             | 8    | 2500 | 356.0       | 356.0      | 35.0        |
| REF5050AIDGKT | VSSOP        | DGK             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| REF5050AIDR   | SOIC         | D               | 8    | 2500 | 356.0       | 356.0      | 35.0        |
| REF5050IDGKR  | VSSOP        | DGK             | 8    | 2500 | 356.0       | 356.0      | 35.0        |
| REF5050IDGKT  | VSSOP        | DGK             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| REF5050IDR    | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |

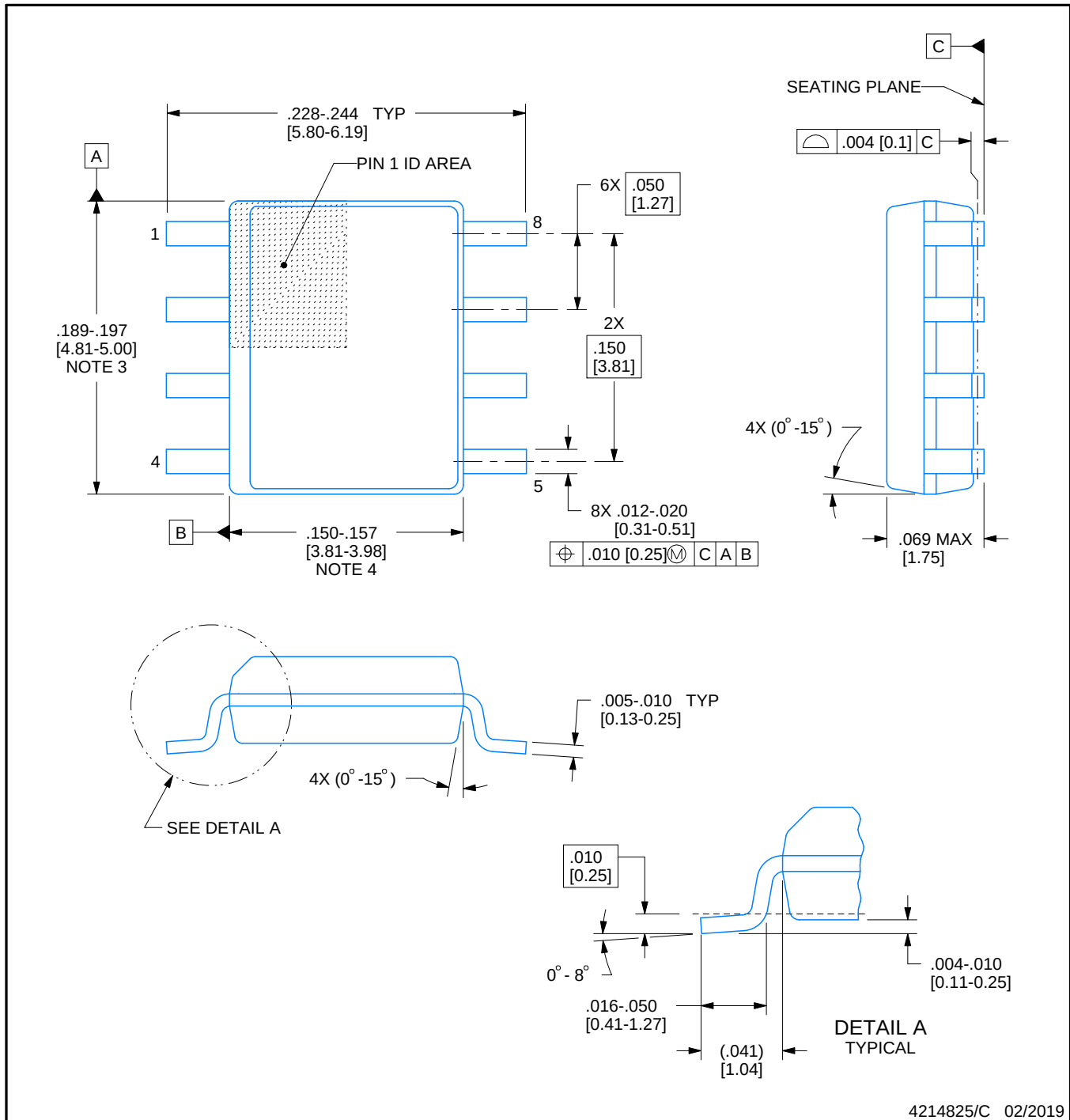
**TUBE**


\*All dimensions are nominal

| Device       | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|--------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| REF5010AID   | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5010ID    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5020AID   | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5020AIDG4 | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5020ID    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5025AID   | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5025AIDG4 | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5025ID    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5025IDG4  | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5030AID   | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5030AIDG4 | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5030ID    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5040AID   | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5040AIDG4 | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5040ID    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5040IDG4  | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5045AID   | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5045AIDG4 | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5045ID    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5050AID   | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5050AIDG4 | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5050ID    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5050IDG4  | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |

**D0008A****PACKAGE OUTLINE****SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

**NOTES:**

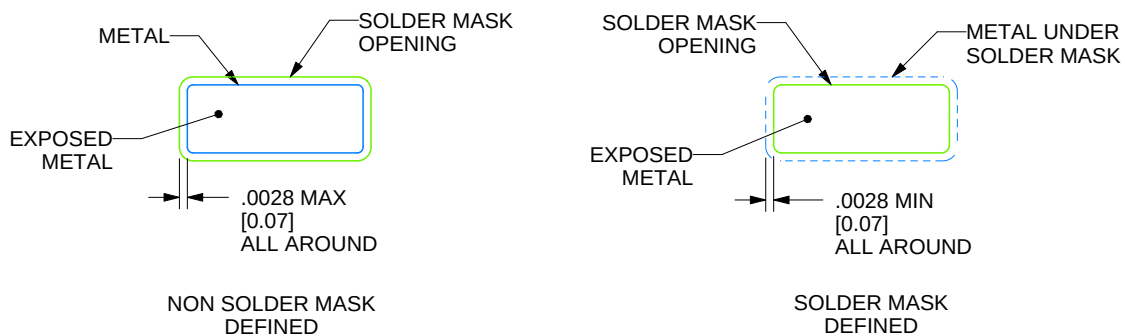
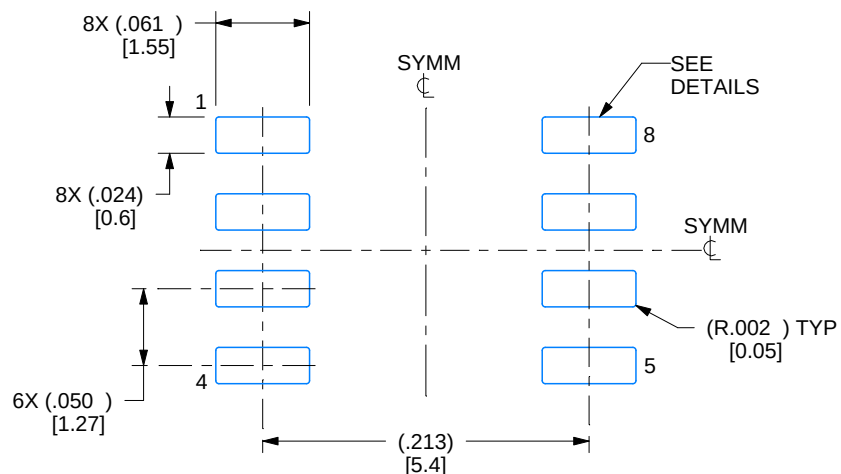
1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

# EXAMPLE BOARD LAYOUT

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

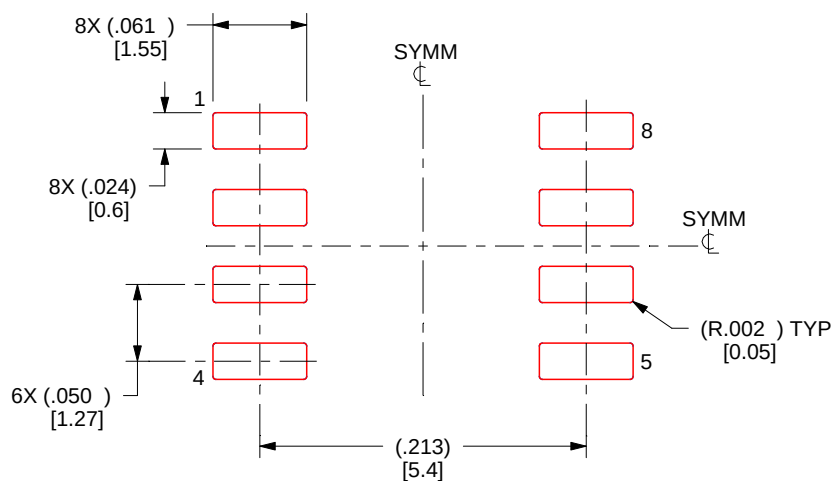
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

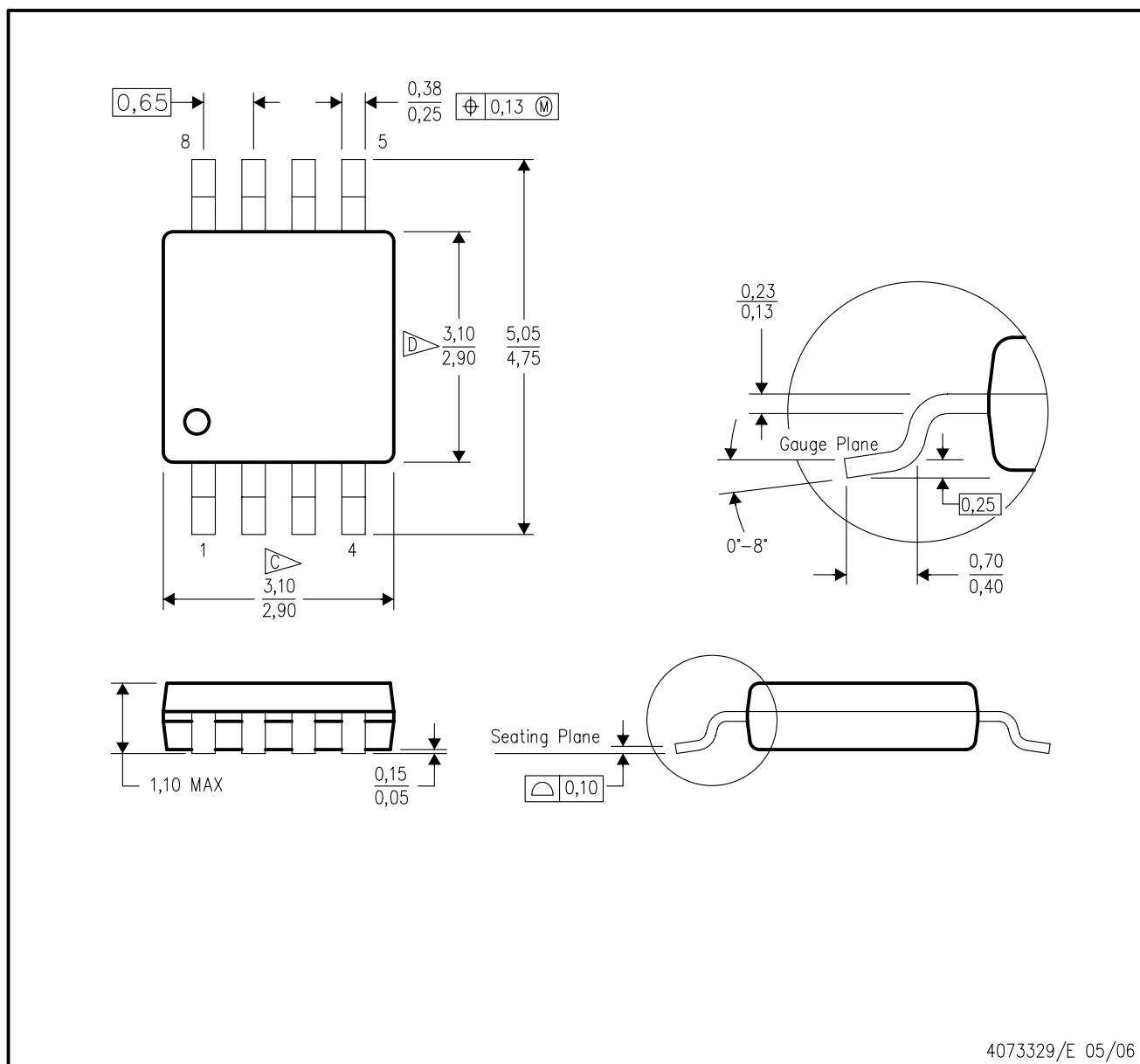
4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## DGK (S-PDSO-G8)

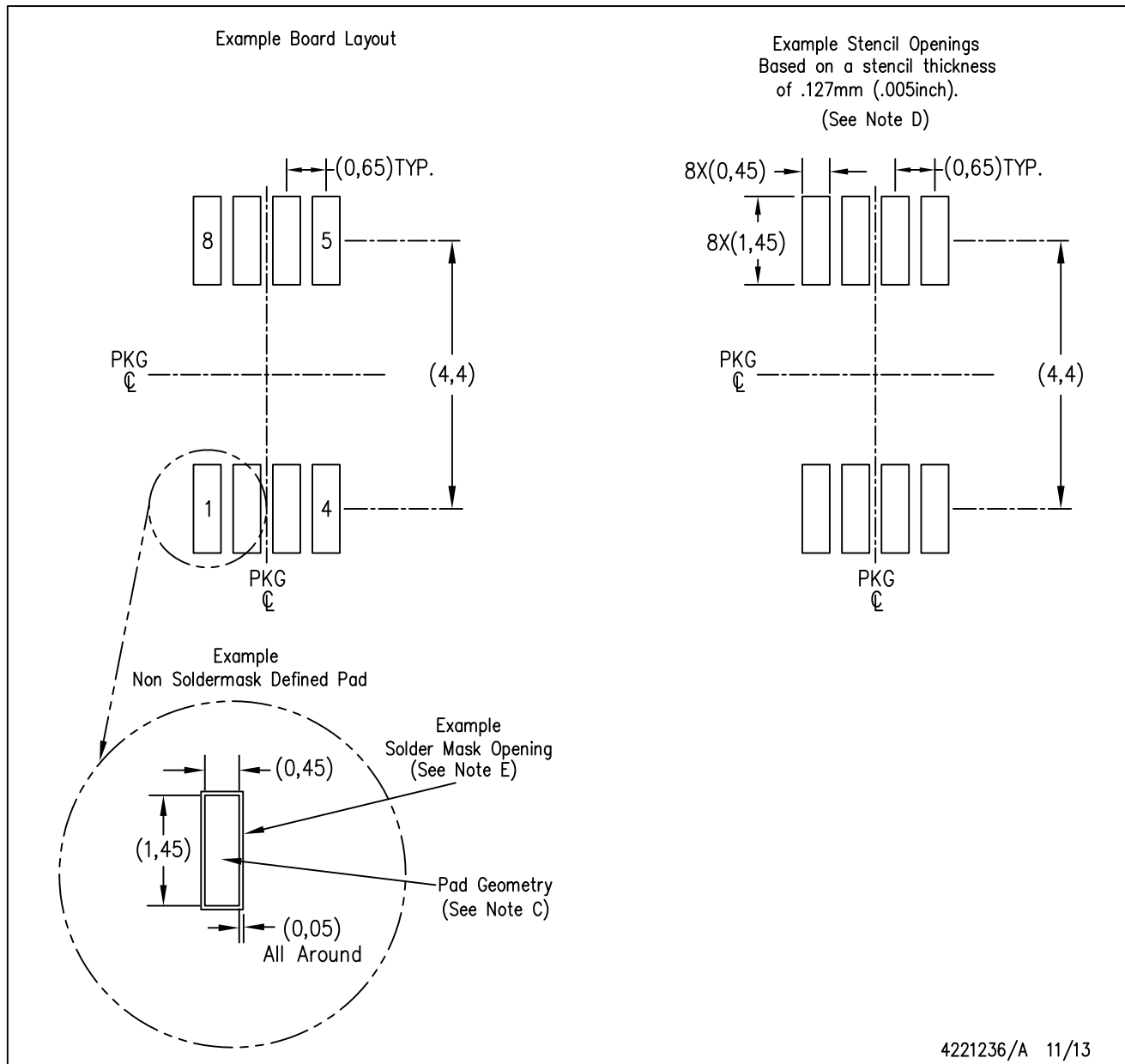
## PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
  - E. Falls within JEDEC MO-187 variation AA, except interlead flash.

DGK (S-PDSO-G8)

PLASTIC SMALL OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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